Overview

HP Z8 G5 Workstation Desktop PC



Front View

- 1. Integrated Front Handle
- 2. Power Button
- 3. HDD Activity LED
- 4. Headphone/microphone combo

- Front I/O: 4 SuperSpeed USB Type-A 5 Gbps signaling rate [left-most Type-A ports supports BC1.2 (Battery Charging)]
- 6. SD Card Reader
- 7. 2x External 5.25" bay¹
- 8. 9.5mm Optical Drive Bay

¹Only 1 external 5.25" drive configurable from factory



Overview



Internal View

- 1. 2 Intel[®] Xeon[®] Processors (Sapphire Rapids-Scalable)
- 2. 16 DIMM slots for DDR5 ECC Memory 8 DIMMs per installed processor
- Slot 1: PCIe x16 Gen4
 Slot 2: PCIe x16 Gen4 Available ONLY when 2nd processor is installed
 Slot 3: PCIe x4 Gen3
 Slot 4: PCIe x16 Gen5
 Slot 5: PCIe x8 Gen3
 Slot 6: PCIe x16 Gen3 Available ONLY when 2nd processor is installed
 Slot 7: PCIe x4 Gen3
- 4. 2 PCIe x8 Gen4 configurable with 4 Z Turbo M.2 SSDs (2nd slot available ONLY when 2nd processor is installed)

- 5. 6 SATA ports
- 3 Internal USB Ports
 (1 single USB2.0 port, 1 dual USB2.0 port, 1 USB3.0 port
 (for the SD card reader))
- 7. 4 Internal 3.5" bays
- 8. 2 External 5.25" bays and Slimline Optical Drive
- 9. 1 Internal NVMe connector to front removable M.2 carrier



Overview



Rear View

- 1. Choice of 90% Efficient Power Supplies:
 - 1125W @110V or 1450W @200V
 - 1450W @110V or 1700W @200V
- 2. Rear Power Button
- 3. Audio in/out
- 6 SuperSpeed USB Type-A 5 Gbps signaling rate 4.

- 5. 2 RJ-45 integrated LAN ports (1 GbE AMT, 1GbE)
- 6. 2 10GbE LAN ports (optional)
- 7. Integrated Rear Handle

Form Factor

Tower

Operating Systems

Preinstalled:

- Windows 11 Pro for Workstations² •
- Windows 11 Pro for Workstations (preinstalled with Windows 10 Pro for Workstations Downgrade),2,3
- Ubuntu 22.04 LTS⁴
- HP Linux®-ready (minimal OS ready for customer OS installation)⁵ •

License Only:

Red Hat® Enterprise Linux® Desktop Workstation (includes paper license with 1 year support; • no preinstalled OS)6

Supported:

- Windows 11, version 22H2, 21H2²
- Windows 10, version 22H2, 21H2²



Overview

- Red Hat[®] Enterprise Linux[®] Workstation 8 & 9⁶
- SUSE Linux[®] Enterprise Desktop 15⁶
- Ubuntu 20.04 & 22.04 LTS⁵

Web-supported only:

- Windows 11 Enterprise^{2,1}
- Windows 10 Enterprise^{2,1}

¹ Windows Enterprise sold separately and requires that customer have an enterprise license from Microsoft.

² Not all features are available in all editions or versions of Windows. Systems may require upgraded and/or separately purchased hardware, drivers, software or BIOS update to take full advantage of Windows functionality. Windows is automatically updated and enabled. High speed internet and Microsoft account required. ISP fees may apply and additional requirements may apply over time for updates. See http://www.windows.com.

³This system is preinstalled with Windows 10 Pro software and also comes with a license for Windows 11 Pro software and provision for recovery software. You may only use one version of the Windows software at a time. Switching between versions will require you to uninstall one version and install the other version. You must back up all data (files, photos, etc.) before uninstalling and installing operating systems to avoid loss of your data.

⁴ Not all features are available in all editions or versions of Ubuntu. Systems may require upgraded and/or separately purchased hardware, drivers, software or BIOS to take full advantage of Ubuntu functionality. Ubuntu may be automatically updated. ISP fees may apply and additional requirements may apply over time for updates.

⁵A certified preloaded version of Ubuntu[®] 20.04 LTS is available from HP for this platform. Not all features are available in all editions or versions of Ubuntu. Systems may require upgraded and/or separately purchased hardware, drivers, software or BIOS to take full advantage of Ubuntu functionality. Ubuntu may be automatically updated. ISP fees may apply, and additional requirements may apply over time for upgrades.

⁶For detailed Linux[®] OS/hardware support information, see:

http://www.hp.com/support/linux_hardware_matrix

NOTE: Your product does not support Windows 8 or Windows 7. In accordance with Microsoft's support policy, HP does not support the Windows® 8 or Windows 7 operating system on products configured with Intel® and AMD® 7th generation and forward processors or provide any Windows® 8 or Windows 7 drivers on http://www.support.hp.com. A full list of HP products and the Windows 10 versions tested is available on the HP support website. https://support.hp.com/us-en/document/c05195282



Overview

Processors

				juency GHz)	Cache	Max Memory Speed (MT/s)	TDP
Name ¹	Cores	Threads	Base Clock Speed	Max Turbo Frequency ²	(MB)	1 DIMM per Channel	(W)
Intel® Xeon® Gold 6448Y	32	64	2.1	4.1	60	4800	225
Intel® Xeon® Gold 6438Y+	32	64	2.0	4.0	60	4800	205
Intel® Xeon® Gold 6430	32	64	2.1	3.4	60	4400	270
Intel® Xeon® Gold 5420+	28	56	2.0	4.1	52.5	4400	205
Intel® Xeon® Gold 6442Y	24	48	2.6	4.0	60	4800	225
Intel® Xeon® Gold 5418Y	24	48	2.0	3.8	45	4400	185
Intel® Xeon® Silver 4416+	20	40	2.0	3.9	37.5	4000	165
Intel® Xeon® Gold 6444Y	16	32	3.6	4.0	45	4800	270
Intel® Xeon® Gold 6426Y	16	32	2.5	4.1	37.5	4800	185
Intel® Xeon® Gold 5416S	16	32	2.0	4.0	30	4400	150
Intel® Xeon® Silver 4410Y	12	24	2.0	3.9	30	4000	150
Intel® Xeon® Gold 6434	8	16	3.7	4.1	22.5	4800	195
Intel® Xeon® Gold 5415+	8	16	2.9	4.1	22.5	4400	150

Notes:

4th Gen Xeon -SP processors all feature Intel[®] vPro[®] Technology³

• 4th Gen Xeon -SP processors all support Hyper-Threading

• 4th Gen Xeon -SP processors do not offer integrated graphics

¹ Multicore is designed to improve performance of certain software products. Not all customers or software applications will necessarily benefit from use of this technology. Performance and clock frequency will vary depending on application workload and your hardware and software configurations. Intel's numbering, branding and/or naming is not a measurement of higher performance.

² Intel Turbo Boost Max (ITBM) performance varies depending on hardware, software and overall system configuration. See http://www.intel.com/technology/turboboost for more information.

³ Intel vPro® requires Windows 10 Pro 64 bit or higher, a vPro supported processor, vPro enabled chipset, vPro enabled wired LAN and/or Wi-Fi 6E WLAN and TPM 2.0. Some functionality requires additional 3rd party software in order to run. Features of vPro® Essentials and Enterprise vary. See http://intel.com/vpro



Overview

Color	Black
Convertibility	No
Expansion Slots (see system board section for more details)	 Slot 1: PCIe x16 Gen4 Slot 2: PCIe x16 Gen4 - Available ONLY when 2nd processor is installed Slot 3: PCIe x4 Gen3 Slot 4: PCIe x16 Gen5 Slot 5: PCIe x8 Gen3 Slot 6: PCIe x16 Gen3 - Available ONLY when 2nd processor is installed Slot 7: PCIe x4 Gen3
Expansion Bays (see storage section for more details)	4 internal 3.5" bays (All 4 include acoustic dampening rail assemblies) 2 external 5.25" bays (175mm depth limit) 1 dedicated 9.5mm slim optical disk drive bay
Front I/O	Front I/O: 4 SuperSpeed USB Type-A 5 Gbps signaling rate, 1 headphone/microphone combo, SD card reader (optional). [left-most Type-A ports supports BC1.2 (Battery Charging)]
Internal I/O [5]	3 Internal USB ports and 6 SATA ports.
Rear I/O	Audio in/out, 6 SuperSpeed USB Type-A 5 Gbps signaling rate, 2 RJ-45 integrated LAN ports (1 GbE AMT, 1GbE)
Optional I/O	2 10GbE LAN ports
On-board RAID Support	SATA RAID 0 Striped Array SATA RAID 1 Mirrored Array SATA RAID 10 Striped/Mirrored SATA RAID 5 Parity Array
Chassis Dimensions (H x W x D)	Footprint: H: 17.5" [444.5mm] W: 8.5" [215.9mm] D: 21.7" [551.2mm] (measured to the rear of service panel) Maximum: H: 17.5" [444.5mm] W: 8.5" [215.9mm] D: 21.85" [555.2mm] (measured to the embossment for the rear chassis fans)
Packaged Dimensions	H: 25" (636mm) W: 13.1" (332mm) D: 28.9" (734mm)
Palletization Profile	4 units x 3 layers = 12 units per pallet 1200x1000x2034mm (pallet included)
Rack Dimensions	5U
Weight	Exact weights depend upon configuration (System weight only). Minimum: 22.5kg (49.6lbs.) Typical: 24.3kg (53.7lbs.) Maximum: 33.8kg (74.6lbs.)
Temperature	Operating: 5° to 40°C (40° to 104°F) ¹ Non-operating: -40° to 60°C (-40° to 140°F) Above 1524 m (5,000 feet) altitude, the maximum operating temperature is reduced by 1° C (1.8° F) for every 305 m (1,000 feet) increase in elevation Maximum rate of change: 10 °C/hr No direct sustained sunlight ¹ 40°C has been validated for configs up to 2x 270W CPU (Intel Xeon Gold 6430), 2x NVIDIA® RTX A4000
	graphics cards, 8x64GB RAM, 4x 2TB M.2 storage, 2x 2TB HDD storage, and 1125W PSU



Chipset Memory	Intel® C741 chipset 16 DIMM slots, supporting up to 1TB, DDR5 4800 MT/s speed depending on the system configuration
Workstation ISV Certifications	See the latest list of certifications at http://www.hp.com/united-states/campaigns/workstations/partnerships.html
	NOTE: updating graphics after purchase may require additional power distribution cables and/or auxiliary graphics adapters to support the new graphics configuration.
	 NOTE: Not all configurations are supported on all power supplies. Configuration support depends on total system power budget and having sufficient number or type of PCIe supplemental power connectors. Confirm power supply and configuration support using configurator on hp.com. 1125W supports up to 600W of auxiliary graphics power (dependent on system configuration) 1450W supports up to 600W of auxiliary graphics power (dependent on system configuration) 1700W supports up to 600W of auxiliary graphics power (dependent on system configuration)
Power Supply	 Choice of 80 Plus Gold (90% efficiency at 50% load) Power Supplies: 1125W @110V/15A (Delta Efficiency Report) 1450W @230V/10A (Delta Efficiency Report)1450W @110V/20A (Delta Efficiency Report) 1700W @230V/10A (Delta Efficiency Report)
Maximum Altitude (non-pressurized)⁵	Operating (with Rotational Hard Drives): 3,048 m (10,000 feet) Operating (with only Solid-State Drives): 5,000 m (16,404 feet) Non-operating: 9,144m (30,000ft) NOTE: Above 1524 m (5,000 feet) altitude, maximum operating temperature is reduced by 1°C (1.8°F) per 305 m (1,000 feet) elevation increase
Humidity	Operating: Operating: 8% to 85% RH, non-condensing, 35° C maximum wet bulb Non-operating: 8% to 90%, non-condensing, 35° C maximum wet bulb

Supported Components

Processors		Factory Configured	Option Kit	Option Kit Part Number	Support Notes
	4th Generation Intel® Xeon® Scalable Processors				
	Intel [®] Xeon [®] Gold 6448Y	Y	Y	6Y3A1AA	1
	Intel [®] Xeon [®] Gold 6444Y	Y	Y	6Y3A8AA	1
	Intel [®] Xeon [®] Gold 6442Y	Y	Y	6Y3A5AA	1
	Intel [®] Xeon [®] Gold 6438Y+	Y	Y	6Y3A2AA	1
	Intel [®] Xeon [®] Gold 6434	Y	Y	6Y3B2AA	1
	Intel [®] Xeon [®] Gold 6430	Y	Y	6Y3A3AA	1
	Intel [®] Xeon [®] Gold 6426Y	Y	Y	6Y3A9AA	1
	Intel [®] Xeon [®] Gold 5420+	Y	Y	6Y3A4AA	1
	Intel [®] Xeon [®] Gold 5418Y	Y	Y	6Y3A6AA	1
	Intel [®] Xeon [®] Gold 5416S	Y	Y	6Y3B0AA	1
	Intel [®] Xeon [®] Gold 5415+	Y	Y	6Y3B3AA	1
	Intel [®] Xeon [®] Silver 4416+	Y	Y	6Y3A7AA	1
	Intel® Xeon® Silver 4410Y	Y	Y	6Y3B1AA	1

NOTE 1: When ordering two processors, the second processor must be the same as the first. Intel processor numbers are not a measurement of higher performance. Processor numbers differentiate features within each processor family, not across different processor families.

SATA Hard Drives		Factory Configured	Option Kit	Option Kit Part Number
	1TB 7200RPM SATA 3.5in Enterprise HDD	Y	Y	WOR10AA
	2TB 7200RPM SATA 3.5in Enterprise HDD	Y	Y	2Z274AA
	4TB 7200RPM SATA 3.5in Enterprise HDD	Y	Y	K4T76AA/AT
	8TB 7200RPM SATA 3.5in Enterprise HDD	Y	Y	2Z273AA
	12TB 7200RPM SATA-6G 3.5in Enterprise HDD	Y	Y	5S461AA

NOTE: Starting November 1, 2023, HP PCs with Windows require Windows to be installed on SSD. HDD can only be configured as additional data drives and not as the boot drive.

PCIe Solid State Drives		Factory Configured	Option Kit	Option Kit Part Number
	Z Turbo 512GB 2280 PCle-4x4 TLC SSD	Y	Y	38T80AA
	Z Turbo 512GB 2280 PCIe-4x4 SED OPAL2 TLC M.2 SSD	Y	Y	38T81AA
	Z Turbo 512GB 2280 PCIe-4x4 TLC Z8 Kit SSD	Ν	Y	360H7AA
	Z Turbo 512GB 2280 PCIe-4x4 SED OPAL2 TLC M.2 Z8 Kit SSD	Ν	Y	360H2AA
	Z Turbo 1TB 2280 PCIe-4x4 SED OPAL2 TLC M.2 SSD	Y	Y	38T76AA
	Z Turbo 1TB 2280 PCIe-4x4 TLC SSD	Y	Y	38T77AA
	Z Turbo 1TB 2280 PCIe-4x4 TLC Z8 Kit SSD	Ν	Y	360H5AA
	Z Turbo 1TB 2280 PCIe-4x4 SED OPAL2 TLC M.2 Z8 Kit SSD	Ν	Y	360H4AA
	Z Turbo 2TB 2280 PCIe-4x4 SED OPAL2 TLC M.2 SSD	Y	Y	38T79AA
	Z Turbo 2TB 2280 PCIe-4x4 TLC SSD	Y	Y	38T75AA



Supported Components

Z Turbo 2TB 2280 PCIe-4x4 SED OPAL2 TLC M.2 Z8 Kit SSD	Ν	Y	360H1AA
Z Turbo 4TB 2280 PCIe-4x4 TLC M.2 SSD ²	Y	Y	5S496AA/AT
Z Turbo 4TB 2280 PCIe-4x4 SED OPAL2 TLC M.2 SSD ²	Y	Y	5S497AA/AT
Z Turbo 4TB 2280 PCIe-4x4 SED OPAL2 TLC M.2 Z8 Kit SSD ²	Ν	Y	5S4A0AA
HP Z Turbo Drive Dual Pro			
HP Z Turbo Drive Dual Pro PCIe-4x4 NVMe Carrier ¹	Y	Y	56Q86AA
HP Z Turbo Drive Dual Pro 512GB TLC SSD	Y	Ν	
HP Z Turbo Drive Dual Pro 1TB TLC SSD	Y	Ν	
HP Z Turbo Drive Dual Pro 2TB TLC SSD	Y	Ν	
HP Z Turbo Drive Dual Pro 4TB TLC SSD ²	Y	Ν	
Intel® Virtual RAID on CPU (Intel® VROC) for NVMe			
Intel VROC NVMe SSD Premium Ctlr Module ³	Ν	Y	3FJ81AA
Intel VROC NVMe SSD Standard Ctlr Module ²	Ν	Y	3FJ80AA

Note 1: Kit includes dual pro carrier and heatsink. Requires separate purchase of Z Turbo PCIe 4x4 M.2 SSD modules.

Note 3: Enables RAID 0, 1 & 10 plus RAID 5 with write hole closure options

NOTE: Internal M.2 PCIe SSDs are installed using HP Personality Card (up to 2 Personality Cards per system). Each Personality Card can support two M.2 drives.

NOTE: For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36GB of system disk (for Windows) is reserved for system recovery software.

Graphics		Factory Configured	Option Kit	Option Kit Part Number	Supported # of cards
Graphics Cable	HP DisplayPort To VGA Adapter	Ν	Y	AS615AA/AT	
Adapters	HP DisplayPort To VGA Adapter	Ν	Y	F7W97AA	
	HP DisplayPort to HDMI Adapter	Y	Y	2JA63AA	
	HP (Bulk 12) miniDP-to-DP Adapter Cables	Ν	Y	2KW87A6	
	HP Single miniDP-to-DP Adapter Cable	Y	Y	2MY05AA	
	HP miniDP-to-DP Adapter (2-pack)	Y	Ν		
	HP miniDP-to-DP Adapter (4-pack)	Y	Ν		
	HP miniDP-to-DP Adapter (8-pack)	Y	Ν		
	HP DisplayPort To DVI Adapter (Bulk 90)	Ν	Y	FH973A6	
	NVIDIA NVLink 3-Slot Bridge	Y	Y	340L3AA	
	NVIDIA 3D Stereo Bracket	Ν	Y	KOA25AA	
Ultra High-End	NVIDIA® RTX 6000 Ada 48GB1	Y	Y	79C23AA/AT	2
Graphics	NVIDIA [®] RTX A6000 48GB	Y	Y	2S6U3AA/AT	2
	AMD Radeon Pro W6800 32 GB ²	Y	Y	340K7AA	2
	NVIDIA [®] RTX A5000 24GB	Y	Y	20X23AA/AT	2
	NVIDIA® Quadro® Sync II	Ν	Y	1WT20AA	
High-End Graphic	s NVIDIA [®] RTX A4500 20GB ¹	Y	Y	5S458AA/AT	2
-	NVIDIA [®] RTX A4000 16GB	Y	Y	20X24AA/AT	2
	NVIDIA [®] Long-Life RTX A4000E 16GB ¹	Y	Y	6H7J7AA	2

Note 2: Enables RAID 0, 1 & 10

Supported Components

Midrange					2
Graphics	NVIDIA [®] RTX A2000 12GB	Y	Y	5Z7D9AA/AT	2
	NVIDIA [®] Long-Life RTX A2000E 12GB	Y	Ν		2
	NVIDIA [®] T1000 8GB	Y	Y	5Z7D8AA/AT	2
	NVIDIA [®] Long-Life T1000E 8GB	Y	Y	6V9V4AA/AT	2
	AMD [®] Radeon™ Pro W6600 8GB ²	Y	Y	340K5AA	2
Entry Graphics	NVIDIA [®] T400 4GB	Y	Y	5Z7E0AA/AT	2
	AMD [®] Radeon™ RX 6400 4GB ²	Y	Y	6Q3U4AA/AT	1
	NVIDIA T1000 4 GB	Y	Y	20X22AA/AT	2
	Intel Arc Pro A40 6GB ¹	Y	Y	6E3Y8AA	1

Note 1: available in Summer 2023

Note 2: 2nd AMD graphic card configurable in Summer 2023

	Factory Configured	Option Kit	Option Kit Part Number	Support Notes
32GB (2x16GB) DDR5 4800 DIMM ECC REG Memory	Y	Ν		
64GB (4x16GB) DDR5 4800 DIMM ECC REG Memory	Y	Ν		1
64GB (2x32GB) DDR5 4800 DIMM ECC REG Memory	Y	Ν		
128GB (8x16GB) DDR5 4800 DIMM ECC REG Memory	Y	Ν		1
128GB (4x32GB) DDR5 4800 DIMM ECC REG Memory	Y	Ν		1
256GB (16x16GB) DDR5 4800 DIMM ECC REG Memory	Y	Ν		2
256GB (8x32GB) DDR5 4800 DIMM ECC REG Memory	Y	Ν		1
256GB (4x64GB) DDR5 4800 DIMM ECC REG Memory	Y	Ν		1
512GB (16x32GB) DDR5 4800 DIMM ECC REG Memory	Y	Ν		2
512GB (8x64GB) DDR5 4800 DIMM ECC REG Memory	Y	Ν		1
1TB (16x64GB) DDR5 4800 DIMM ECC REG Memory	Y	Ν		2
After Market Options				
16GB (1x16GB) DDR5 4800 DIMM ECC REG Memory	Y	Y	340K1AA	
32GB DDR5 (1x32GB) 4800 DIMM ECC REG Memory	Ν	Y	340K2AA	
64GB DDR5 (1x64GB) 4800 DIMM ECC REG Memory	Ν	Y	340K3AA	

Note 1: Memory configuration is available for both single and dual CPU configurations. **Note 2:** Memory configuration is only available with dual CPU configuration.

Multimedia and Audio Devices		Factory Configured	Option Kit	Option Kit Part Number
	HyperX Cloud Mix Wireless Gaming Headset	Ν	Y	4P5K9AA
	HyperX Cloud Core Gaming Headset	Ν	Y	4P4F2AA
	HyperX Cloud Flight Wireless Gaming Headset	Ν	Y	4P5L4AA
	HyperX Cloud Stinger Core Gaming Headset	Ν	Y	4P4F4AA
	HyperX SoloCast - USB Microphone	Ν	Y	4P5P8AA
	Integrated Realtek ALC 3205-CG	Y	Ν	



Supported Components

Optical and Removable		Factory Configured	Option Kit	Option Kit Part Number
Storage	HP CRU QX428 Removable with 415mm Cable Frame/Carrier ¹	Y	Ν	
	HP DX175 Removable HDD Frame/Carrier ²	Y	Y	1ZX71AA
	HP DX175 Removable HDD Spare Carrier ²	Ν	Y	1ZX72AA
	HP CRU Secure High Performance Storage Module with 2TB M.2 SSD ³	Y	Y	56Q87AA
	HP CRU Secure High Performance Storage Module with 1TB M.2 SSD ³	Y	Y	56Q88AA
	HP CRU Secure High Performance Storage Module with 512GB M.2 SSD ³	Y	Y	56Q89AA
	HP 9.5mm Slim DVD-ROM Drive	Y	Y	K3R63AA
	HP 9.5mm Slim BDXL Blu-Ray Writer Drive	Y	Y	K3R65AA
	HP 9.5mm Slim SuperMulti DVD Writer	Y	Y	K3R64AA

Note 1: Optional separate purchase of HP CRU Secure High Performance Storage (SHIPS) Module(s). **Note 2:** Only supports 4TB or lower capacity HDDs. **Note 3:** HP CRU SHIPS Module Kit contains select M.2 SSD for install into a factory configured front removeable storage carrier (HP CRU QX428 Frame/Carrier).

Networking and Communications		Factory Configured	Option Kit	Option Kit Part Number
	HP Dual Port 10GbE NIC G2	Y	Y	360K6AA
	Intel® X550 10GBASE-T Dual Port NIC	Y	Y	1QL46AA
	Intel [®] I225-T1 Single Port 2.5GbE PCIe NIC	Y	Y	406L9AA
	Intel® Ethernet I350-T4 4-Port 1Gb NIC	Ν	Y	W8X25AA
	Allied Telesis AT-2914SX/LC-901 1GB LC Fiber NIC	Y	Y	1C7Q2AA
	Allied Telesis AT-2911T/2-901 Dual Port 1GbE NIC	Y	Y	6E3Y9AA/AT
	NVIDIA [®] Mellanox [®] ConnectX-6 DX Dual Port 10/25GbE SFP28 NIC	Y	Y	436M8AA
	HP 10GbE SFP+ SR/SW LC Fiber Optic Transceiver	Y	Y	860T8AA
	HP 25GbE SFP28 LC Fiber Optic Transceiver	Y	Y	860T9AA
	Intel AX210 Wi-Fi 6E non-vPro + Bluetooth® 5.2 wireless card with External Antenna WLAN	Y	Y	340L7AA

Note1: Transceivers sold separately. You must have a transceiver installed to connect this card to a network.

HP Anyware Remote System Controller		Factory Configured	Option Kit	Option Kit Part Number
	HP Anyware Remote System Controller*	Y	Y	7K6D7AA
	HP Anyware Remote System Controller Main Board Adapter*	Y	Y	7K6D8AA
	HP Z4/Z6/Z8 G4 / ZCentral 4R Remote System Controller Cable Adapter	Y	Y	7K6E5AA
	HP Anyware Integrated Remote System Controller	Y	Y	7K6D9AA
	HP Anyware Remote System Controller for Universal KVM	Ν	Y	7K7N2AA



Supported Components

*Separate purchase of kit 7K6E5AA HP Z4/Z6/Z8 G4/ZCentral 4R Remote System Controller Cable Adapter is required. Kit 7K6E5AA includes the PCIe bracket required to mount the bulkhead PCA for either 7K6D7AA or 7K6D8AA when using with the HP Z4/Z6/Z8 G4, ZCentral 4R, or Z8G5, which do not have a dedicated bulkhead knockout for the bulkhead PCA adapter.

Racking and Physical Security		Factory Configured	Option Kit	Option Kit Part Number
	HP Z640/Z840/Z8 G4 Rail Rack Kit	Ν	Y	2FZ77AA/AT
	HP Z8 Rack Rail Upgrade Kit	Ν	Y	2FZ76AA/AT

Input Devices		Factory Configured	Option Kit	Option Kit Part Number
	HP 320K Wired Keyboard	Y	Y	9SR37AA/ET/UT
	HP 125 Wired Keyboard	Y	Y	266C9AA/ET/UT
	HP 975 USB+BT Dual-Mode Wireless Keyboard	Ν	Y	3Z726AA/ET/UT
	HP 455 Programmable Wireless Keyboard	Ν	Y	4R177AA/ET/UT/A6
	HP Wired Desktop 320MK Mouse and Keyboard	Ν	Y	9SR36AA/ET/UT
	HP 655 Wireless Keyboard and Mouse Combo	Ν	Y	4R009AA/ET/UT/A6
	HyperX Alloy MKW100 - Mechanical Gaming Keyboard	Ν	Y	4P5E1AA
	HP Wired 320M Mouse	Y	Y	9VA80AA/ET/UT
	HP Creator 935 Black Wireless Mouse	Ν	Y	1D0K8AA/ET/UT
	HP 128 LSR Wired Mouse	Y	Y	265D9AA/ET/UT
	HP 125 Wired Mouse	Ν	Y	265A9AA/ET/UT
	HyperX Pulsefire Haste Black Wireless Gaming Mouse 2	Ν	Y	6N0B0AA
	HyperX Pulsefire Haste White Wireless Gaming Mouse 2	Ν	Y	6N0A9AA
	HyperX Pulsefire Core - Gaming Mouse	Ν	Y	4P4F8AA
	HP Business Slim Smartcard Keyboard	Y	Y	Z9H48AA/AT

NOTE: Keyboard and Mouse are optional or add on features.

Other Hardware		Factory Configured	Option Kit	Option Kit Part Number
	HP C13 1.83m Power Cord Kit (halogen-free)	Y	Ν	
	HP Z8 1450W C19 2.5m Power Cord Kit ^{3,**}	Ν	Y	6Z9V1AA
	HP 2.5in to 3.5in HDD Adapter Kit	Ν	Y	J5T63AA/A6
	HP Internal Serial+PS/2 Port	Y	Y	56Q78AA
	HP Dual TBT4 PCIe x4 Low Profile Card⁵	Y	Y	340L1AA
	HP USB 2.0 Type-A Port Adapter Kit⁴	Y	Y	79C24AA
	HP 2.5in HDD/SSD 2-in-1 Optical Bay Bracket	Ν	Y	K4T74AA
	HP Optical Bay HDD Mounting Bracket ¹	Ν	Y	NQ099AA
	HP SD 4 Card Reader Zx G4	Y	Y	2VK54AA
	HP C13 1.83m Power Cord Kit ^{2,*}	Ν	Y	6Z1T9AA



Supported Components

*Does not support HP Z8 G5 1450W PSU. **Does not support HP Z8 G5 1125W PSU.

Note 1: NQ099AA HP Optical Bay HDD Mounting Bracket is required as a separate purchase for HDD option kits installed into an external bay.
Note 2: 6Z1T9AA is only for 1125W PSU Z8 G5.
Note 3: 6Z9V1AA is only for 1450W PSU Z8 G5.
Note 4: The USB 2.0 Type-A Port Adapter Kit has a single USB 2.0 type A connector.
Note 5: Available in July 2023

Software		Factory Configured	Option Kit	Support Notes
	HP Anyware	Y	Ν	
	HP Performance Advisor	Y	Ν	1
	HP PC Hardware Diagnostics UEFI (Windows OS only)	Y	Ν	2
	HP PC Hardware Diagnostics Windows	Y	Ν	
	HP Wolf Security	Y	Ν	3
	HP Notifications	Y	Ν	
	HP Desktop Support Utility	Y	Ν	
	HP Documentation	Y	Ν	
	myHP	Y	Ν	
	HP Easy Clean	Y	Ν	
	Kingsoft WPS Office	Y	Ν	4
	Z by HP Data Science Stack Manager	Y	Ν	5,6
	WSL2/Ubuntu Data Science Stack	Y	Ν	5
	HP Image Assistant	Ν	Ν	
	HP Support Assistant	Ν	Ν	
	HP Smart Health	Ν	Ν	

Note 1: Supported with Windows only. Also available as a free download from http://www.hp.com/go/performanceadvisor
Note 2: Windows OS only
Note 3: Not available in Russia
Note 4: Not available in China
Note 5: Only available with NVIDIA[®] graphics
Note 6: Only available with Ubuntu

Operating Systems Windows 11 Pro for Workstations^{1,2}

Windows 11 Pro for Workstations (preinstalled with Windows 10 Pro for Workstations Downgrade)^{1,2,3} Ubuntu 22.04 LTS⁴ HP Linux[®]-ready

¹ Windows Enterprise sold separately and requires that customer have an enterprise license from Microsoft. ² Not all features are available in all editions or versions of Windows. Systems may require upgraded and/or separately purchased hardware, drivers, software or BIOS update to take full advantage of Windows functionality. Windows is automatically updated and enabled. High speed internet and Microsoft account



Supported Components

required. ISP fees may apply and additional requirements may apply over time for updates. See http://www.windows.com.

³This system is preinstalled with Windows 10 Pro software and also comes with a license for Windows 11 Pro software and provision for recovery software. You may only use one version of the Windows software at a time. Switching between versions will require you to uninstall one version and install the other version. You must back up all data (files, photos, etc.) before uninstalling and installing operating systems to avoid loss of your data.

⁴ Not all features are available in all editions or versions of Ubuntu. Systems may require upgraded and/or separately purchased hardware, drivers, software or BIOS to take full advantage of Ubuntu functionality. Ubuntu may be automatically updated. ISP fees may apply and additional requirements may apply over time for updates.

NOTE: Your product does not support Windows 8 or Windows 7. In accordance with Microsoft's support policy, HP does not support the Windows[®] 8 or Windows 7 operating system on products configured with Intel[®] and AMD[®] 7th generation and forward processors or provide any Windows[®] 8 or Windows 7 drivers on http://www.support.hp.com. A full list of HP products and the Windows 10 versions tested is available on the HP support website. https://support.hp.com/us-en/document/c05195282



Supported Components

HP BIOS

Key features of the HP BIOS include:

- Deployment and manageability HP BIOS provides several technologies that help integrate the HP Z8 G5 Workstation into the enterprise, such as PXE, remote recovery, remote configuration, remote control, and BIOS (F10) Setup support for 15 languages.
- Network firmware updates Update your BIOS via the cloud or standardize on a BIOS version hosted on an Enterprise network.
- Stability HP BIOS supports the HP stable product roadmap by releasing only critical BIOS changes to the factory and advanced change notification.
- Class 3 UEFI specification version 2.7
- Absolute Persistence agent For tracking and tracing services, available in select countries, separate software and purchase of a subscription is required.
- Thermal and power management The HP BIOS provides and enables thermal and power management technologies so component temperatures are managed for high reliability and to assist in operating the HP Workstation computer in any enterprise environment.
- Acoustic performance Industry leading acoustic emissions across the range of operating conditions.
- Serviceability HP BIOS provides diagnostic and detailed service information.
- Upgrades and recovery HP BIOS provides numerous ways to upgrade HP Workstation computers, including BIOS updates from within Windows (HP Firmware Update and Recovery), Capsule update, HP Client Manager, and fail-safe recovery. In addition, the HP BIOS Configuration Utility enables replication of BIOS settings within Windows while the Replicated Setup feature provides the same capability within BIOS (F10) Setup. The BIOS Configuration Utility is available from the HP support website.
- HP BIOS uses PKI signing of the BIOS for trusted BIOS upgrades and recovery. Additional HP BIOS Features:
 - Power-On password Helps prevent an unauthorized user from powering on the system.
 - Administrator password Also known as the BIOS Setup password, this helps prevent unauthorized changes to the system configuration. If the administrator password is not known, the BIOS cannot be updated and changes cannot be made to BIOS settings using BIOS Setup or under the OS.
 - S4/S5 Maximum Power Savings setting supports EU Lot6 requirement and allows the computer to power down below 0.5W in S4/S5 (when turned off). When S4/S5 Maximum Power Savings feature is enabled below features are turned off:
 - Power to expansion connectors / slots
 - Most Wake events other than power buttons and WOL (Wake on LAN supported by embedded Lan controller under S4/S5 Maximum Power Saving Enabled)
 - USB charging ports

HP Sure Start Gen7

- BIOS Integrity checking Sure Start protection ensures that only trusted BIOS code is executed and not rootkits, viruses and malware. Verification is done upon boot up, shutdown and while the system is on.
- Sure Start is set by default to automatically repair the BIOS if corrupted or compromised but is policy driven for better manageability. Start is set by default to automatically repair the BIOS if corrupted or compromised but is policy driven for better manageability.
- Protecting beyond BIOS Integrity checking and repair is extended to other data that should be protected such as network configuration parameters, platform specific information (i.e. system IDs), secure boot credentials, and other code the system needs to boot.
- Audit enabled System Audit via Sure Start Event Logs capture data such as incident, repair date and time for troubleshooting and investigating.



Supported Components

SOFTWARE COMPONENTS AND APPLICATIONS WITH WINDOWS

BIOS

HP BIOSphere Gen6¹³ HP DriveLock & Automatic DriveLock BIOS Update via Network Master Boot Record Security Power On Authentication Absolute Persistence Module²³ Pre-boot Authentication HP Wireless Wakeup

Software

HP Desktop Support Utility HP Performance Advisor¹ HP Privacy Settings HP Notifications myHP HP Services Scan²⁵

Manageability Features

HP Driver Packs² HP System Software Manager (SSM) HP BIOS Config Utility (BCU) HP Client Catalog HP Manageability Integration Kit Gen6³

Client Security Software

HP Wolf Security (Including HP Sure Click & HP Sure Sense)²² HP Pro Wolf Security (Including Credential Manager)¹⁸ HP Client Security Manager Gen 7⁴ HP Sure Run⁹ HP Sure Recover¹⁰ HP Power On Authentication Microsoft Defender⁷

Security Management

HP Security Update Service (SUS) Secure Erase¹⁶ TPM 2.0 Embedded Security Chip(Common Criteria EAL4+ Certified)²⁴ SATA port disablement (viaBIOS) Serial, USB enable/disable (viaBIOS) Power-on password (viaBIOS) Setup password (viaBIOS) Support for chassis padlocks and cable lock devices Integrated hood sensor0 HP Sure Start Gen4⁸

¹ HP Performance Advisor Software - HP Performance Advisor is ready to help you get the most out of your HP Workstation from day one—and every day after. Learn more or download at: http://hp.com/PerformanceAdvisor

² HP Driver Packs not preinstalled, however available for download at http://www.hp.com/go/clientmanagement.

³ HP Manageability Integration Kit can be downloaded from https://ftp.ext.hp.com/pub/caps-softpaq/cmit/HPMIK.html

⁴ HP Client Security Manager Gen7 requires Windows and is available on the select HP PCs.



Supported Components

⁷ Microsoft Defender Opt in and internet connection required for updates.

⁸ HP Sure Start Gen 7 is available on select HP PCs and workstations. See product specifications for availability.

⁹ HP Sure Run Gen5 is available on select Windows 11 based HP Pro, Elite and Workstation PCs with select Intel[®] or AMD processors

¹⁰ HP Sure Recover Gen4 is available on select HP PCs and requires Windows 10 and an open network connection. You must back up important files, data, photos, videos, etc. before using HP Sure Recover to avoid loss of data. Network based recovery using Wi-Fi is only available on PCs with Intel Wi-Fi Module

¹³ HP BIOSphere Gen6 features may vary depending on the platform and configurations.

¹⁶ Secure Erase - For the methods outlined in the National Institute of Standards and Technology Special Publication 800-88 "Clear" sanitation method. HP Secure Erase does not support platforms with Intel® Optane.

¹⁸ HP Wolf Pro Security Edition is available preloaded on select SKUs and, depending on the HP product purchased, includes a paid 1-year or 3-year license. The HP Wolf Pro Security Edition software is licensed under the license terms of the HP Wolf Security Software - End-User license Agreement (EULA) that can be found at: https://support.hp.com/us-

en/document/ish_3875769-3873014-16 as that EULA is modified by the following: "7. Term. Unless otherwise terminated earlier pursuant to the terms contained in this EULA, the license for the HP Wolf Pro Security Edition (HP Sure Sense Pro and HP Sure Click Pro) is effective upon activation and will continue for either a twelve (12) month or thirty-six (36) month license term ("Initial Term"). At the end of the Initial Term you may either (a) purchase a renewal license for the HP Wolf Pro Security Edition from HP.com, HP Sales or an HP Channel Partner, or (b) continue using the standard versions of HP Sure Click and HP Sure Sense at no additional cost with no future software updates or HP Support.

²² HP Wolf Security for Business requires Windows 10 or higher, includes various HP security features and is available on HP Pro, Elite, RPOS and Workstation products. See product details for included security features

²³ Absolute agent is shipped turned off, and will be activated when customers activate a purchased subscription. Subscriptions can be purchased for terms ranging multiple years. Service is limited, check with Absolute for availability outside the U.S. The Absolute Recovery Guarantee is a limited warranty. Certain conditions apply. For full details visit: http://www.absolute.com/company/legal/agreements/computrace-agreement. Data Delete is an optional service provided by Absolute Software. If utilized, the Recovery Guarantee is null and void. In order to use the Data Delete service, customers must first sign a Pre-Authorization Agreement and either obtain a PIN or purchase one or more RSA SecurID tokens from Absolute Software.

²⁴ Firmware TPM is version 15.21. Hardware TPM is v2.0.

²⁵ HP Services Scan is provided with Windows Update on select products and will check entitlement on each hardware device to determine if an HP TechPulse-enabled service has been purchased, and will download applicable software automatically. HP TechPulse is a telemetry and analytics platform that provides critical data around devices and applications. For full system requirements or to disable this feature, please visit http://www.hpdaas.com/requirements . Not applicable in China.



System Technical Specifications

System Board

-,						
System Board Form Factor	Approximately 415.04mm x 386	5.08mm (16.34 x 15.20 inches)				
Processor Socket	Dual LGA-4677					
CPU Bus Speed	DMI Gen3 x 8 lanes. 3 UPI x24 interconnects betwee	n CPUs that operate at 16GT/s				
Chipset	Intel C741 Emmitsburg PCH					
Super I/O Controller	Nuvoton SIO21					
Memory Expansion Slots	16 DDR5 memory slots (only 8 D	DR5 memory slots with single CPU installed)				
Memory Type Supported	DDR5, RDIMM (Registered) ECC					
Memory Modes	Non-Interleaved for single chan	nel. Interleaved when multiple channels are populated				
Memory Speed Supported	Max memory speed is processor 4800MT/s DDR5 or 4400MT/s D	-dependent, refer to processor table for more details: DR5 or 4000MT/s DDR5				
Memory Protection	ECC	C				
Maximum Memory	1TB	В				
Memory Configuration (Supported)	•	6GB, 32GB and 64GB RDIMMs are supported. 4GB RDIMMs cannot be mixed with other module capacities in the same system.				
NVDIMM Memory	No					
PCI Express Connectors	 1 PCI Express Gen4 slot x16 me 1 PCI Express Gen3 slot x8 mee 1 PCI Express Gen3 slot x4 mee CPU0 Personality Slots: 1 PCI Express Gen4 slot x8 mee devices per personality slot) CPU0 Other PCIe Connections 1 Front NVMe Storage SlimSAS 1 10GbE (PCIe Gen3 x4) CPU 1 Standard PCIe Slots: 1 PCI Express Gen4 slot x16 me 1 PCI Express Gen3 slot x16 me 1 PCI Express Gen4 slot x16 me 1 PCI Express Gen4 slot x8 mee 	echanical/ x16 electrical (full height, full length) echanical/ x16 electrical (full height, full length) chanical/ x8 electrical (full height, full length) chanical/ x4 electrical (full height, full length) chanical/ x8 electrical (full height, half length) (supports two x4 M.2 chanical/ x8 electrical (full height, half length) (supports two x4 M.2 chanical/ x16 electrical (full height, full length) echanical/ x16 electrical (full height, full length) echanical/ x16 electrical (full height, full length) echanical/ x16 electrical (full height, full length)				
	devices per personality slot) PCH Standard PCIe Slots:					
	•	chanical/ x4 electrical (full height, full length)				
Supported Drive Interfaces	SATA	Number of SATA ports: 6 Intel® SATA controller: secondary SATA				
	Integrated RAID	On-board RAID Support Intel® VROC® SATA RAID 0, 1, 5, and 10 supported on Windows 10 and 11, RHEL 8.6 and later, SLE 15 SP4 and later Intel® VROC® NVMe RAID 0, 1, 5, and 10 supported with presence of appropriate VROC upgrade module (after-market kits) on Windows 10 and 11, RHEL 8.6 and later, SLE 15 SP4 and later				



System Technical Specifications

		Factory Configured RAID: None
	Integrated Graphics	No
	Network Controller	Intel WGI210AT and WGI219LM. WGI219LM LOM provides Management capabilities: WOL, PXE 2.1, DASH 1.1 and AMT
	External SATA (eSATA)	No
	Serial	1 internal header (requires optional Serial Port Adapter Kit)
	2nd Serial	No
	HD Integrated Audio	Yes
USB Connector(s)	Front	Front I/O: 4x USB 3.1 Gen1 Type-A (left-most port supports Battery Charging 1.2) • Charging USB Type-A port provides 1.5 Amps @ 5 Volts • Standard USB Type-A Ports provide 900mA @ 5 Volts
	Rear	6x USB 3.1 Gen1 Type-A via USB hub.
	Internal	1 USB 3.1 Gen1 (via USB hub) header, with a single 12-pin shrouded connector. This header supports a USB Media Card reader. 1 USB 2.0 single port header 1 USB 2.0 dual port header
Flash ROM	Yes	
CPU Fan Header	Yes (CPU0 and CPU1)	
Memory Fan Header	No	
Chassis Fan Header	Yes (2)	
Front PCI Fan Header	Via Aux fan header if needed.	
Front Control	Yes	
Panel/Speaker Header		
CMOS Battery Holder - Lithium	Yes	
Integrated Trusted Platform Module	Integrated TPM 2.0. Convertible to FIPS 140-2 Certi The TPM module is disabled wh	fied Mode through firmware v15.21. here restricted by law.
Power Supply Headers	Yes	
Power Switch, Power LED & Hard Drive LED Header	Yes	
Clear Password Jumper	Yes	
Keyboard/Mouse	USB and PS/2 (option)	
•	•	stems, such as Genuine Windows [®] 1 <mark>1</mark> Professional 64 bit, Red Hat Linux
² M.2 storage supports con	npatible devices up to 80mm	

²M.2 storage supports compatible devices up to 80mm



System Technical Specifications

System Configuratio		1						
Example Configuration	Processor Info	1x Intel® Xeor	n® 5415+ 8C 2.	9GHz 150W				
#1	Memory Info	32GB DDR5 (2x16GB) RegRAM						
	Graphics Info	1x NVIDIA [®] A2000						
	Disks/Optical/Floppy	1x 1TB Internal SATA HDD + 1x DVDRW SATA						
	PSU	1125W						
	Other	N/A						
Energy Consumption		115	VAC	230	VAC	100	VAC	
(Watts)		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	
	Windows Idle (SO)	97.	783	93.	632	96.	522	
	Windows Busy Typ (SO)	255	.653	253	3.33	252	2.18	
	Windows Busy Max (SO)	258	.699	253	.884	253	.224	
	Sleep (S3)	4.266	4.178	4.246	4.189	4.218	4.176	
	Off (S5)	1.689	1.681	1.699	1.697	1.654	1.631	
	Zero Power Mode (EuP)	0.2	221	0.3	323	0.2	219	
Heat Dissipation (Btu/hr)		115 VAC		230 VAC		100 VAC		
(btu/iii)		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	
	Windows Idle (SO)	333	.635	319.472		329.333		
	Windows Busy Typ (SO)	872	.288	864.362		860.438		
	Windows Busy Max (SO)	882	.681	866.252		864.000		
	Sleep (S3)	14.556	14.255	14.487	14.293	14.392	14.249	
	Off (S5)	5.763	5.736	5.797	5.790	5.643	5.565	
	Zero Power Mode (EuP)	0.7	754	1.1	102	0.7	747	
Example Configuration	Processor Info	2x Intel® Xeor	n® 5415+ 8C 2.	9GHz 150W				
#2	Memory Info	64GB DDR5 (4	1x16GB) RegRA	١M				
	Graphics Info	1x NVIDIA® A4	4000					
	Disks/Optical/Floppy	2x 1TB SATA I	HDD + 2x 4TB I	nternal M.2 SS	5D + 1x DVDRW	SATA		
	PSU	1125W						
	Other	N/A						
Energy Consumption		115	VAC	230	VAC	100	VAC	
(Watts)		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	
	Windows Idle (SO)	167	.365	158	.346	166	5.35	
	Windows Busy Typ (SO)	474	.655	472	.688	471	.555	
					772.000			

 Off (S5)
 2.217
 2.117
 2.237
 2.268
 2.208
 2.104

 Zero Power Mode (EuP)
 0.246
 0.351
 0.238

 Introduction of the second second

508.788

5.682

5.785

506.355

5.488

5.564

Windows Busy Max (SO)

Sleep (S3)



506.141

5.418

5.543

System Technical Specifications

		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled
	Windows Idle (SO)	571.049		540.277		567.586	
Heat Dissipation	Windows Busy Typ (SO)	1619	.523	1612.811		1608.946	
(Btu/hr)	Windows Busy Max (SO)	1735.985		1727.683		1726.953	
	Sleep (S3)	19.738	19.387	18.984	18.725	18.913	18.486
	Off (S5)	7.564	7.223	7.633	7.738	7.534	7.179
	Zero Power Mode (EuP)	0.839		1.197		0.812	
Example Configuration	Processor Info	2x Intel® Xeon® 6426Y 2.6GHz 16C 185W					
#3	Memory Info	256GB DDR5 (16x16GB) RegRAM					
	Graphics Info	1x NVIDIA® A6000					
	Disks/Optical/Floppy	4x 4TB Interna	al M.2 SSD + 1	x DVDRW SATA			
	PSU	1450W					
	Other	N/A					

Energy Consumption		115 VAC		230 VAC		100 VAC	
(Watts)		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled
	Windows Idle (SO)	200.685		196.652		198.568	
	Windows Busy Typ (SO)	627.685		625.992		625.147	
	Windows Busy Max (SO)	658.742		654.668		653.472	
	Sleep (S3)	7.689	7.599	7.674	7.569	7.673	7.558
	Off (S5)	2.425	2.418	2.498	2.459	2.368	2.407
	Zero Power Mode (EuP)	0.278		0.469		0.269	

Heat Dissipation		115 VAC		230 VAC		100 VAC	
(Btu/hr)		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled
	Windows Idle (SO)	684.737		670.977		677.514	
	Windows Busy Typ (SO)	2141	.661	2135	5.885	2133	3.002
	Windows Busy Max (SO)	2247	7.628	2233	3.727	2229	9.646
	Sleep (S3)	26.235	25.928	26.184	25.825	26.180	25.788
	Off (S5)	8.274	8.250	8.523	8.390	8.080	8.213
	Zero Power Mode (EuP)	0.9	949	1.6	682	0.9	918

Example Configuration #4	Processor Info	2x Intel® Xeon® 6430 32C 1.9GHz 270W
	Memory Info	1024GB DDR5 (16x64GB) RegRAM
	Graphics Info	2x NVIDIA® A6000
	Disks/Optical/Floppy	4x 4TB Internal M.2 SSD + 1x DVDRW SATA
	PSU	1450W
	Other	N/A

Energy Consumption		115 VAC		230 VAC		100 VAC	
(Watts)		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled
	Windows Idle (SO)	238.	.334	216	.387	236.	.884



System Technical Specifications

Windows Busy Typ (SO)	830	.883	827.	664	826	.456
Windows Busy Max (SO)	977	.655	974.	662	973	.481
Sleep (S3)	18.864	18.175	18.688	18.162	18.674	18.1
Off (S5)	2.738	2.718	2.748	2.729	2.721	2.70
Zero Power Mode (EuP)	0.2	297	0.4	38	0.2	96

Heat Dissipation		115 VAC		230 VAC		100 VAC	
(Btu/hr)		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled
	Windows Idle (S0)	813.196		738.312		808.248	
	Windows Busy Typ (SO)	2834.973		2823.990		2819.868	
	Windows Busy Max (SO)	3335	5.759	3325	5.547	3321	.517
	Sleep (S3)	64.357	62.013	63.763	61.969	63.716	61.808
	Off (S5)	9.342	9.274	9.376	9.311	9.284	9.229
	Zero Power Mode (EuP)	1.0)13	1.7	'34	1.0)10

NOTE: The numbers in this table are from actual measurements on a single system. There will be some variation from unit to unit.

NOTE: The busy power number and associated BTU/hr number for each configuration will be a strong function of the actual application software run on the system. There can be a great deal of variation in this number.

NOTE: The Power Supply Efficiency report may be found at the following links: https://www.plugloadsolutions.com/80PlusPowerSuppliesDetail.aspx?id=0&type=2



System Technical Specifications

Operating Voltage Range Rated Voltage Range Rated Line Frequency Operating Line Frequency Range	100-240 VAC 50-60 Hz
ENERGY STAR [®] certified (Config Dependent)	Yes
CECP Compliant @ 220V	Yes
FEMP Standby Power Compliant	Yes, with Wake-on-LAN disabled: <1W in S5 - Power Off
Built-in Self Test (BIST) LED	Yes
Surge Tolerant Full Ranging Power Supply (withstands power surges up to 2000V)	Yes
Hood Lock Header	Yes
ErP Lot 6- Tier 1 Compliance @ 230V (<1W in S5 - Power Off)	Yes
ErP Lot 6- Tier 2 Compliance @ 230V (<0.5W in S5 - Power Off)	Yes

Declared Noise Emissions	(Entry-level, Mid-level, ar	nd High-end configurations; tested on flo	or)				
System Configuration	Processor Info	1 x Intel Sapphire Rapids 16C 150W					
(Entry level)	Memory Info	2 x 16GB DDR5-4800 RDIMM					
	Graphics Info	1 x NVIDIA RTX A2000	1 x NVIDIA RTX A2000				
	Disks/Optical	1 x 1TB HDD / Blu-Ray R/RE DVD+/-RW					
	Power Supply	1125W					
Declared Noise Emissions		Sound Power (LWAd, bels)	Deskside Sound Pressure (LpAm, decibels)				
	Idle	3.8	19				
	Hard drive Operating (Drive Random Seek)	3.9	20				
	Active Mode	3.8	19				
System Configuration	Processor Info	2 x Intel Sapphire Rapids 16C 150W					
(Mid-level)	Memory Info	4 x 16GB DDR5-4800 RDIMM					
	Graphics Info	1 x NVIDIA RTX A4000					
	Disks/Optical	2 x 512GB M.2 + 2 x 1TB HDD / Blu-Ray	2 x 512GB M.2 + 2 x 1TB HDD / Blu-Ray DVD+/-RW				
	Power Supply	1125W					
Declared Noise Emissions		Sound Power (LWAd, bels)	Deskside Sound Pressure (LpAm, decibels)				
	Idle	3.7	19				
	Hard drive Operating (Drive Random Seek)	3.8	21				



System Technical Specifications

	Active Mode	3.8	20				
System Configuration	Processor Info	2 x Sapphire Rapids 32C 270W	2 x Sapphire Rapids 32C 270W				
(High-end)	Memory Info	16 x 64 GB DDR5-4800 RDIMM	16 x 64 GB DDR5-4800 RDIMM				
	Graphics Info	2 × NVIDIA RTX A6000					
	Disks/Optical	4 x 4TB M.2 + 4 x 8TB HDD / Blu-Ray DVD+/-RW					
	Power Supply	1450W					
Declared Noise Emissions		Sound Power (LWAd, bels)	Deskside Sound Pressure (LpAm, decibels)				
	Idle	4.0	24				
	Hard drive Operating (Drive Random Seek)	4.2	24				
	Active Mode	4.1	24				

Environmental Requirements	Temperature	Operating: 5° to 40°C (40° to 104°F) ¹ Non-operating: -40° to 60°C (-40° to 140°F)
		¹ 40°C has been validated for configs up to 2x 270W CPU (Intel Xeon Gold 6430), 2x NVIDIA® RTX A4000 graphics cards, 8x64GB RAM, 4x 2TB M.2 storage, 2x 2TB HDD storage, and 1125W PSU
	Humidity	Operating: 8% to 85% RH, non-condensing Non-operating: 8% to 90% RH, non-condensing
	Maximum Altitude	Operating (with Rotational Hard Drives): 3,048 m (10,000 feet) Operating (with only Solid-State Drives): 5,000 m (16,404 feet)
		Non-operating: 9,144 m (30,000 feet)
	Dynamic	Shock Operating: ½-sine: 40g, 2-3ms (~62 cm/sec) Non-operating: ½-sine: 160 cm/s, 2-3ms (~105g) square: 422 cm/s, 20g NOTE: Values represent individual shock events and do not indicate repetitive shock events
		Vibration Operating random: 0.5g (rms), 5-300 Hz, up to 0.0025g²/Hz Non-operating random: 2.0g (rms), 5-500 Hz, up to 0.0150 g²/Hz NOTE: Values do not indicate continuous vibration.
	Cooling	Above 1524 m (5,000 feet) altitude, the maximum operating temperature is reduced by 1° C (1.8° F) for every 305 m (1,000 feet) increase in elevation, up to 3048 m (10,000 feet)



System Technical Specifications

Physical Security and Serviceability

Thysical Security a	······································
Access Panel	Tool-less Includes system board and memory information
Optical Drive	Tool-less, 2nd Optical Drive requires a 5.25" bay carrier
Hard Drives	Tool-less
Expansion Cards	Tool-less
Processor Socket	Screw-in processor coolers
Blue User Touch Points	Yes, on tool-less internal chassis mechanisms
Color-coordinated Cables and Connectors	Yes
Memory	Tool-less
System Board	Tool-less, retained by Front Card Guide and Top Memory Fan Holder
Power and HD LED on Front of Computer	Yes
Configuration Record SW	Yes
Over-Temp Warning on	Yes
Screen	
Dual Function Front Power Switch	Yes, causes a fail-safe power off when held for 4 seconds
Padlock Support	No
Cable Lock Support	Yes, Kensington Cable Lock (optional): Prevents entire system theft only. 3mm x 7mm slot at rear of system
Universal Chassis Clamp	No
Lock Support	
Solenoid Lock and Hood Sensor	No
	No
Sensor	
Sensor Rear Port Control Cover Serial, USB, Audio, Network, Enable/Disable	No
Sensor Rear Port Control Cover Serial, USB, Audio, Network, Enable/Disable Port Control Removable Media	No Yes
Sensor Rear Port Control Cover Serial, USB, Audio, Network, Enable/Disable Port Control Removable Media Write/Boot Control	No Yes Yes
Sensor Rear Port Control Cover Serial, USB, Audio, Network, Enable/Disable Port Control Removable Media Write/Boot Control Power-On Password	No Yes Yes
Sensor Rear Port Control Cover Serial, USB, Audio, Network, Enable/Disable Port Control Removable Media Write/Boot Control Power-On Password Setup Password 3.3V Aux Power LED on	No Yes Yes Yes, prevents an unauthorized person from changing the workstation configuration.
Sensor Rear Port Control Cover Serial, USB, Audio, Network, Enable/Disable Port Control Removable Media Write/Boot Control Power-On Password Setup Password 3.3V Aux Power LED on System PCA NIC LEDs (integrated)	No Yes Yes Yes, prevents an unauthorized person from changing the workstation configuration. None
Sensor Rear Port Control Cover Serial, USB, Audio, Network, Enable/Disable Port Control Removable Media Write/Boot Control Power-On Password Setup Password 3.3V Aux Power LED on System PCA NIC LEDs (integrated) (Green & Amber) CPUs and Heatsinks	No Yes Yes Yes, prevents an unauthorized person from changing the workstation configuration. None Yes A torx driver (T30) is needed to remove the processor heatsink. CPU attached to heatsink via tool-less clip
Sensor Rear Port Control Cover Serial, USB, Audio, Network, Enable/Disable Port Control Removable Media Write/Boot Control Power-On Password Setup Password 3.3V Aux Power LED on System PCA NIC LEDs (integrated) (Green & Amber) CPUs and Heatsinks	No Yes Yes Yes, prevents an unauthorized person from changing the workstation configuration. None Yes A torx driver (T30) is needed to remove the processor heatsink. CPU attached to heatsink via tool-less clip
Sensor Rear Port Control Cover Serial, USB, Audio, Network, Enable/Disable Port Control Removable Media Write/Boot Control Power-On Password Setup Password 3.3V Aux Power LED on System PCA NIC LEDs (integrated) (Green & Amber) CPUs and Heatsinks	No Yes Yes Yes, prevents an unauthorized person from changing the workstation configuration. None Yes A torx driver (T30) is needed to remove the processor heatsink. CPU attached to heatsink via tool-less clip Yes
Sensor Rear Port Control Cover Serial, USB, Audio, Network, Enable/Disable Port Control Removable Media Write/Boot Control Power-On Password Setup Password 3.3V Aux Power LED on System PCA NIC LEDs (integrated) (Green & Amber) CPUs and Heatsinks Power Supply Diagnostic LED Front Power Button	No Yes Yes Yes, prevents an unauthorized person from changing the workstation configuration. None Yes A torx driver (T30) is needed to remove the processor heatsink. CPU attached to heatsink via tool-less clip Yes Yes, white (normal), red (fault)
Sensor Rear Port Control Cover Serial, USB, Audio, Network, Enable/Disable Port Control Removable Media Write/Boot Control Power-On Password Setup Password 3.3V Aux Power LED on System PCA NIC LEDs (integrated) (Green & Amber) CPUs and Heatsinks Power Supply Diagnostic LED Front Power Button Front Power LED Front Power LED	No Yes Yes Yes, prevents an unauthorized person from changing the workstation configuration. None Yes A torx driver (T30) is needed to remove the processor heatsink. CPU attached to heatsink via tool-less clip Yes Yes, white (normal), red (fault)
Sensor Rear Port Control Cover Serial, USB, Audio, Network, Enable/Disable Port Control Removable Media Write/Boot Control Power-On Password Setup Password 3.3V Aux Power LED on System PCA NIC LEDs (integrated) (Green & Amber) CPUs and Heatsinks Power Supply Diagnostic LED Front Power Button Front Power LED Front Hard Drive Activity LED	No Yes Yes Yes, prevents an unauthorized person from changing the workstation configuration. None Yes A torx driver (T30) is needed to remove the processor heatsink. CPU attached to heatsink via tool-less clip Yes Yes, white (normal), red (fault) Yes, white



System Technical Specifications

System/Emergency ROM Flash Recovery	Yes
Cooling Solutions	Air cooled forced convection
Power Supply Fans	2x - Dual Side Inlet Blowers
CPU Heatsink Fan	92 mm x 92 mm x 25.4 mm for each CPU
Chassis Fan	Rear: 120 mm x 38 mm Front Lower: 120 mm x 25.4 mm (PCIe zone)
Memory Heatsink Fan	Front Upper: 92mm x 25mm (upper memory bank); Front Middle: 80mm x 25mm (lower memory bank)
HP PC Hardware Diagnostics UEFI	HP PC Hardware Diagnostics (UEFI) enables hardware level testing outside the operating system on many components. The diagnostics can be invoked by pressing F2 at POST, and is available as a download from HP Support.
Access Panel Key Lock	Yes, left access panel
ACPI-Ready Hardware	 Advanced Configuration and Power Management Interface (ACPI). Allows the system to wake from a low power mode. Controls system power consumption, making it possible to place individual cards and peripherals in a low-power or powered-off state without affecting other elements of the system.
Integrated Chassis Handles	Yes, front and rear
Power Supply	Tool-less, rear access direct-connect (blind-mate)
PCI Card Retention	Yes, rear (all), middle (full-height cards), front (cards with extender)
Flash ROM	Yes
Diagnostic Power Switch LED on board	Yes
Clear Password Jumper	Yes
Clear CMOS Button	Yes
CMOS Battery Holder	Yes
DIMM Connectors	Yes

Service, Support, and Warranty

On-site Warranty and Service¹: One-year, limited warranty and service offering delivers on-site, next business-day² service for parts and labor and includes free telephone support³ 8am - 5pm. Global coverage² ensures that any product purchased in one country and transferred to another, non-restricted country will remain fully covered under the original warranty and service offering. 24/7 operation will not void the HP warranty. Storage devices are not covered under warranty for 24/7 operation except for Enterprise class HDDs.

NOTE 1: Terms and conditions may vary by country. Certain restrictions and exclusions apply.

NOTE 2: On-site service may be provided pursuant to a service contract between HP and an authorized HP third-party provider, and is not available in certain countries. Global service response times are based on commercially reasonable best effort and may vary by country.

NOTE 3: Technical telephone support applies only to HP-configured, HP and HP-qualified, third-party hardware and software. Toll-free calling and 24x7 support service may not be available in some countries.

HP Care Pack Services extend service contracts beyond the standard warranties. Service starts from date of hardware purchase. To choose the right level of service for your HP product, use the HP Care Pack Services Lookup Tool at:

http://www.hp.com/go/lookuptool. Service levels and response times for HP Care Packs may vary depending on your geographic location.

Certification and Compliance

Environmental Sustainability questions concerning:

• Ecolabels (EPEAT, TCO, etc.)



System Technical Specifications

- ENERGY STAR, California Energy Commission (CEC)
- Compliance with Environmental legislation (EU ErP, China CECP, EU RoHS and other countries)
- Supply Chain Social Environmental Responsibility (SER) (conflict minerals; human rights, etc.)
- Product specific environmental features (material content, packaging content, recycled content, etc.)
- China Energy Label (CEL)

Please contact sustainability@hp.com

For country specific Regulatory Compliance approval documents or Regulatory and Safety questions concerning:

- Declarations of Conformity (for self-service, go to https://www.hp.com/uken/certifications/technical/regulations-certificates.html?jumpid=ex_r135_uk/en/any/corp/hpukmu_chev/certificates)
- GS Certificates
- Product Safety Certificates (UL, CB, BIS, etc.)
- EMC Certificates, Declarations of Conformity, or Certificates of Conformity (CE, FCC, ICES, etc.)
- CCC Certificates
- Ergonomics

Please contact techregshelp@hp.com

BIOS

2.00	
PCIe 5.0 Support	Full BIOS support for PCI Express through industry standard interfaces. Supported speeds and slot information vary.
ΑΤΑ/ΑΤΑΡΙ	AT Attachment 6 with Packet Interface (ATA/ATAPI-6), Revision 3b
WMI Support	WMI is Microsoft's implementation of Web-Based Enterprise Management (WBEM) for Windows. WMI is fully compliant with the Distributed Management Task Force (DMTF) Common Information Model (CIM) and WBEM specifications.
BIOS Power On	Users can define a specific date and time for the system to power on.
ROM Based Computer Setup Utility (F10)	Review and customize system configuration settings controlled by the BIOS.
System/Emergency ROM Flash Recovery with Video	Recovers system BIOS in corrupted Flash ROM.
Replicated Setup	Saves BIOS settings to USB flash device in human readable file (HpSetup.txt). BiosConfigurationUtility.exe utility can then replicate these settings on machines being deployed without entering Computer Configuration Utility (F10 Setup).
SMBIOS	System Management BIOS Reference Specification, Version 3.2
Boot Control	Disables the ability to boot from removable media on supported devices.
Memory Change Alert	Alerts management console if memory is removed or changed.
Thermal Alert	Monitors the temperature state within the chassis. Three modes:
	NORMAL - normal temperature ranges.
	• ALERTED - excessive temperatures are detected. Raises a flag so action can be taken to avoid shutdown or provide for a smoother system shutdown.
	• SHUTDOWN - excessive temperatures are encountered. Automatically shuts down the computer
	without warning before hardware component damage occurs.
Remote ROM Flash	Provides secure, fail-safe ROM image management from a central network console.
ACPI (Advanced	Allows the system to enter and resume from low power modes (sleep states).
Configuration and Power	Enables an operating system to control system power consumption based on the dynamic workload.
Management Interface)	Makes it possible to place individual cards and peripherals in a low-power or powered-off state without affecting other elements of the system.
	Supports ACPI 6.0 for full compatibility with 64-bit operating systems.
Ownership Tag	A user-defined string stored in non-volatile memory that is displayed in the BIOS splash screen.



System Technical Specifications

Remote Wakeup/Remote Shutdown	System administrators can power on, restart, and power off a client computer from a remote location.
Instantly Available PC (Suspend to RAM - ACPI sleep state S3)	Allows for very low power consumption with quick resume time.
Remote System Installation via F12 (PXE 2.1) (Remote Boot from	Allows a new or existing system to boot over the network and download software, including the operating system.
Server) ROM revision levels	Reports the system BIOS revision level in Computer Configuration Utility (F10 Setup). Version is available through an industry standard interface (SMBIOS and WMI) so that management SW applications can use and report this information.
System board revision level	Allows management SW to read revision level of the system board. Revision level is digitally encoded into the HW and cannot be modified.
Start-up Diagnostics (Power-on Self-Test)	Assesses system health at boot time with selectable levels of testing.
Auto Setup when new hardware installed	System automatically detects addition of new hardware.
Keyboard-less Operation	The system can be booted without a keyboard.
Localized ROM Setup	Common BIOS image supports System Configuration Utility (F10 Setup) menus in 15 languages with local keyboard mappings.
Asset Tag	The user or MIS to set a unique tag string in non-volatile memory.
Per-slot Control	Allows I/O slot parameters (option ROM enable/disable, bifurcation, speed) to be configured individually.
Adaptive Cooling	Control parameters are set according to detected hardware configuration for optimal acoustics.
Pre-boot Diagnostics	(Pre-video) critical errors are reported via beeps and blinks on the power LED.
UEFI Specification Revision	2.7
REVISION	
ACPI	Advanced Configuration and Power Management Interface, Version 6.0
	Advanced Configuration and Power Management Interface, Version 6.0 "El Torito" Bootable CD-ROM Format Specification Version 1.0
ACPI	
ACPI CD Boot	"El Torito" Bootable CD-ROM Format Specification Version 1.0
ACPI CD Boot EHCI	"El Torito" Bootable CD-ROM Format Specification Version 1.0 Enhanced Host Controller Interface for Universal Serial Bus, Revision 1.0 PCI Express Base Specification, Revision 2.0 PCI Express Base Specification, Revision 3.0 PCI Express Base Specification, Revision 4.0
ACPI CD Boot EHCI PCI Express	"El Torito" Bootable CD-ROM Format Specification Version 1.0 Enhanced Host Controller Interface for Universal Serial Bus, Revision 1.0 PCI Express Base Specification, Revision 2.0 PCI Express Base Specification, Revision 3.0 PCI Express Base Specification, Revision 4.0 PCI Express Base Specification, Revision 5.0 Serial ATA Specification, Revision 1.0a Serial ATA 3 Gb/s: Serial ATA Specification, Revision 2.5
ACPI CD Boot EHCI PCI Express SATA	"El Torito" Bootable CD-ROM Format Specification Version 1.0 Enhanced Host Controller Interface for Universal Serial Bus, Revision 1.0 PCI Express Base Specification, Revision 2.0 PCI Express Base Specification, Revision 3.0 PCI Express Base Specification, Revision 4.0 PCI Express Base Specification, Revision 5.0 Serial ATA Specification, Revision 1.0a Serial ATA 3 Gb/s: Serial ATA Specification, Revision 2.5 Serial ATA 6 Gb/s: Serial ATA Specification, Revision 3.0 JEDEC JESD300-5 Trusted Computing Group TPM Specification Version 2.0 (Infineon SLB 9672). Common Criteria EAL4+ certified. FIPS 140-2 Certification TCG TPM Certified products list:
ACPI CD Boot EHCI PCI Express SATA SPD	"El Torito" Bootable CD-ROM Format Specification Version 1.0 Enhanced Host Controller Interface for Universal Serial Bus, Revision 1.0 PCI Express Base Specification, Revision 2.0 PCI Express Base Specification, Revision 3.0 PCI Express Base Specification, Revision 4.0 PCI Express Base Specification, Revision 5.0 Serial ATA Specification, Revision 5.0 Serial ATA Specification, Revision 1.0a Serial ATA 3 Gb/s: Serial ATA Specification, Revision 2.5 Serial ATA 6 Gb/s: Serial ATA Specification, Revision 3.0 JEDEC JESD300-5 Trusted Computing Group TPM Specification Version 2.0 (Infineon SLB 9672). Common Criteria EAL4+ certified. FIPS 140-2 Certification TCG TPM Certified products list: http://www.trustedcomputinggroup.org/certification/tpm-certified-products/
ACPI CD Boot EHCI PCI Express SATA SPD TPM	 "El Torito" Bootable CD-ROM Format Specification Version 1.0 Enhanced Host Controller Interface for Universal Serial Bus, Revision 1.0 PCI Express Base Specification, Revision 2.0 PCI Express Base Specification, Revision 3.0 PCI Express Base Specification, Revision 4.0 PCI Express Base Specification, Revision 5.0 Serial ATA Specification, Revision 1.0a Serial ATA 3 Gb/s: Serial ATA Specification, Revision 2.5 Serial ATA 6 Gb/s: Serial ATA Specification, Revision 3.0 JEDEC JESD300-5 Trusted Computing Group TPM Specification Version 2.0 (Infineon SLB 9672). Common Criteria EAL4+ certified. FIPS 140-2 Certification TCG TPM Certified products list: http://www.trustedcomputinggroup.org/certification/tpm-certified-products/ Universal Host Controller Interface Design Guide, Revision 1.1 Universal Serial Bus Revision 1.1 Specification Universal Serial Bus Revision 3.2 Specification
ACPI CD Boot EHCI PCI Express SATA SPD TPM	 "El Torito" Bootable CD-ROM Format Specification Version 1.0 Enhanced Host Controller Interface for Universal Serial Bus, Revision 1.0 PCI Express Base Specification, Revision 2.0 PCI Express Base Specification, Revision 3.0 PCI Express Base Specification, Revision 4.0 PCI Express Base Specification, Revision 5.0 Serial ATA Specification, Revision 1.0a Serial ATA 3 Gb/s: Serial ATA Specification, Revision 2.5 Serial ATA 6 Gb/s: Serial ATA Specification, Revision 3.0 JEDEC JESD300-5 Trusted Computing Group TPM Specification Version 2.0 (Infineon SLB 9672). Common Criteria EAL4+ certified. FIPS 140-2 Certification TCG TPM Certified products list: http://www.trustedcomputinggroup.org/certification/tpm-certified-products/ Universal Host Controller Interface Design Guide, Revision 1.1 Universal Serial Bus Revision 2.0 Specification Universal Serial Bus Revision 3.1 Specification Universal Serial Bus Revision 3.1 Specification Universal Serial Bus Revision 3.2 Specification



System Technical Specifications

Eco-Label Certifications & Declarations	mental Responsibility This product is low halogen except for HP Z Turbo Quad Pro PCIe TLC SSD, CRU QX428 removable storage frames, ConnectX-6 DX Amphenol 10 & 25 Gb Transceivers, power cords, cables, and peripherals. Service parts obtained after purchase may not be Low Halogen.					
Sustainable Impact Specifications	only) • US Federal Energy Manage • EPEAT [®] Gold registered wo • TCO Certified • China Energy Conservation	ving features available on selected ment Program (FEMP) rldwide Program (CECP) Protection Administration (SEPA)				
	 Outside Box and corrugated cushions are 100% sustainably sourced and recyclable Recycled Plastic cushions 					
System Configuration	The configuration used for the Ener a "Typically Configured Desktop Wo		e Emissions data is based o			
Energy Consumption (in accordance with US						
(in accordance with US ENERGY STAR® test meth		230VAC, 50Hz	100VAC, 50Hz			
(in accordance with US ENERGY STAR® test meth Normal Operation (Sort idl	le) 187.49 W	191.59 W	197.06 W			
(in accordance with US ENERGY STAR® test meth Normal Operation (Sort id Normal Operation (Long ic	le) 187.49 W ile) 184.27 W	191.59 W 187.92 W	197.06 W 184.67 W			
(in accordance with US ENERGY STAR® test meth Normal Operation (Sort id Normal Operation (Long ic Sleep	le) 187.49 W dle) 184.27 W 14.66 W	191.59 W 187.92 W 13.58 W	197.06 W 184.67 W 14.57 W			
	le) 187.49 W lle) 184.27 W 14.66 W 2.49 W	191.59 W 187.92 W	197.06 W 184.67 W			
(in accordance with US ENERGY STAR® test meth Normal Operation (Sort id Normal Operation (Long ic Sleep	le) 187.49 W dle) 184.27 W 14.66 W	191.59 W 187.92 W 13.58 W 2.63 W IN ENERGY STAR® compliant product the ENERGY STAR® Logo are compli EPA) ENERGY STAR® specifications fo © compliant configurations, then en ng a hard disk drive, a high efficience	197.06 W 184.67 W 14.57 W 2.49 W ant with the applicable U.S or computers. If a model ergy efficiency data listed			
(in accordance with US ENERGY STAR® test meth Normal Operation (Sort id Normal Operation (Long ic Sleep	le) 187.49 W dle) 184.27 W 14.66 W 2.49 W NOTE: Energy efficiency data listed is for a family . HP computers marked with Environmental Protection Agency (E family does not offer ENERGY STAR for a typically configured PC featuri	191.59 W 187.92 W 13.58 W 2.63 W IN ENERGY STAR® compliant product the ENERGY STAR® Logo are compli EPA) ENERGY STAR® specifications fo © compliant configurations, then en ng a hard disk drive, a high efficience	197.06 W 184.67 W 14.57 W 2.49 W ant with the applicable U.S or computers. If a model ergy efficiency data listed			
(in accordance with US ENERGY STAR® test meth Normal Operation (Sort id Normal Operation (Long id Sleep Off	le) 187.49 W dle) 184.27 W 14.66 W 2.49 W NOTE: Energy efficiency data listed is for a family . HP computers marked with Environmental Protection Agency (E family does not offer ENERGY STAR for a typically configured PC featuri Microsoft Windows® operating syste 115VAC, 60Hz	191.59 W 187.92 W 13.58 W 2.63 W In ENERGY STAR® compliant product the ENERGY STAR® Logo are compli EPA) ENERGY STAR® specifications fo © compliant configurations, then en ng a hard disk drive, a high efficience em.	197.06 W 184.67 W 14.57 W 2.49 W ant with the applicable U.S or computers. If a model ergy efficiency data listed y power supply, and a			
(in accordance with US ENERGY STAR® test meth Normal Operation (Sort id Normal Operation (Long id Sleep Off Heat Dissipation*	le) 187.49 W dle) 184.27 W 14.66 W 2.49 W NOTE: Energy efficiency data listed is for a family . HP computers marked with Environmental Protection Agency (B family does not offer ENERGY STAR for a typically configured PC featuri Microsoft Windows® operating syste 115VAC, 60Hz dle) 641.2 BTU/hr	191.59 W 187.92 W 13.58 W 2.63 W IN ENERGY STAR® compliant product the ENERGY STAR® Logo are compli EPA) ENERGY STAR® specifications for © compliant configurations, then en ng a hard disk drive, a high efficience em. 230VAC, 50Hz	197.06 W 184.67 W 14.57 W 2.49 W and with the applicable U.S or computers. If a model ergy efficiency data listed y power supply, and a 100VAC, 50Hz			
(in accordance with US ENERGY STAR® test meth Normal Operation (Sort id Normal Operation (Long id Sleep Off Heat Dissipation* Normal Operation (Short id	le) 187.49 W dle) 184.27 W 14.66 W 2.49 W NOTE: Energy efficiency data listed is for a family . HP computers marked with Environmental Protection Agency (B family does not offer ENERGY STAR for a typically configured PC featuri Microsoft Windows® operating syste 115VAC, 60Hz dle) 641.2 BTU/hr	191.59 W 187.92 W 13.58 W 2.63 W In ENERGY STAR® compliant product the ENERGY STAR® Logo are compli EPA) ENERGY STAR® specifications for compliant configurations, then en ng a hard disk drive, a high efficience em. 230VAC, 50Hz 655.2 BTU/hr	197.06 W 184.67 W 14.57 W 2.49 W if offered within the mod ant with the applicable U. or computers. If a model ergy efficiency data listed y power supply, and a 100VAC, 50Hz 673.9 BTU/hr			



System Technical Specifications

***NOTE:** Heat dissipation is calculated based on the measured watts, assuming the service level is attained for one hour.

Declared Noise Emissio	ns			
(in accordance with		Sound Power	Sound Press	ure
ISO 7779 and ISO 9296)		(L _{WAd} , bels)	(L _{pAm} , decibe	els)
Typically Configured – Id	lle	3.8	19	
Drive Random Seek		3.9	20	
Active Mode		3.8	19	
Longevity and Upgrading		be upgraded, possibly extendi components contained in the	ng its useful life by several years. L	Jpgradeable
	Spare parts are a production.	available throughout the warra	nty period and or for up to "5" years	s after the end of
Additional Information	 This pro - 2011/ 		Restrictions of Hazardous Substanc	es (RoHS) directive
	(WEEE)	Directive – 2002/96/EC.	with the Waste Electrical and Electr	
	Water a	and Toxic Enforcement Act of 19		· · ·
	•	oduct is in compliance with the l peat.net	IEEE 1680 (EPEAT) standard at the (Gold level, see
	 Plastics IS01043 		used in the product are marked per	IS011469 and
	• This pro	oduct is 95.1% recycle-able who	en properly disposed of at end of lif	e.
Packaging Materials	External:	PAPER/Corrugated		2000 g
		PAPER/Corrugated		70 g
	Internal:	PLASTIC/Polyethylene low	density - LDPE	46 g
		PLASTIC/Polyethylene Expa	anded - EPE	450 g
	The plastic packa	aging material contains at leas	t 95.1% recycled content.	
	The corrugated p	paper packaging materials cont	ains at least 35.0% recycled conter	ıt.
RoHS Compliance	restrictions in th products worldw	e European Union (EU) Restrict	s. We were among the first compan ion of Hazardous Substances (RoHS s contributed to the development o d Vietnam.	5) Directive to our
	elimination of su	ubstances of concern. We have : FRs, and certain phthalates—ir	play an important role in promoting supported the inclusion of additiona n future RoHS legislation that pertai	al substances—
	for virtually all re	elevant products by July 2013,	dwide compliance with the new EU and we will continue to extend the ances as regulations continue to ev	scope of the
	To obtain a copy	of the HP RoHS Compliance St	atement, see HP RoHS position stat	ement.
		•		

System Technical Specifications

Material Usage

This product does not contain any of the following substances in excess of regulatory limits (refer to the HP General Specification for the Environment at http://www.hp.com/hpinfo/globalcitizenship/environment/supplychain/gen_specifications.html):

- Asbestos
- Certain Azo Colorants
- Certain Brominated Flame Retardants may not be used as flame retardants in plastics
- Cadmium
- Chlorinated Hydrocarbons
- Chlorinated Paraffins
- Bis(2-Ethylhexyl) phthalate (DEHP)
- Benzyl butyl phthalate (BBP)
- Dibutyl phthalate (DBP)
- Diisobutyl phthalate (DIBP)
- Formaldehyde
- Halogenated Diphenyl Methanes
- Lead carbonates and sulfates
- Lead and Lead compounds
- Mercuric Oxide Batteries
- Nickel finishes must not be used on the external surface designed to be frequently handled or carried by the user.
- Ozone Depleting Substances
- Polybrominated Biphenyls (PBBs)
- Polybrominated Biphenyl Ethers (PBBEs)
- Polybrominated Biphenyl Oxides (PBBOs)
- Polychlorinated Biphenyl (PCB)
- Polychlorinated Terphenyls (PCT)
- Polyvinyl Chloride (PVC) except for wires and cables, and certain retail packaging has been voluntarily removed from most applications.
- Radioactive Substances
- Tributyl Tin (TBT), Triphenyl Tin (TPT), Tributyl Tin Oxide (TBTO)

Packaging Usage HP follows these guidelines to decrease the environmental impact of product packaging:

- Eliminate the use of heavy metals such as lead, chromium, mercury and cadmium in packaging materials.
- Eliminate the use of ozone-depleting substances (ODS) in packaging materials.
- Design packaging materials for ease of disassembly.
- Maximize the use of post-consumer recycled content materials in packaging materials.
- Use readily recyclable packaging materials such as paper and corrugated materials.
- Reduce size and weight of packages to improve transportation fuel efficiency.
- Plastic packaging materials are marked according to ISO 11469 and DIN 6120 standards.

End-of-life Management and Recycling HP offers end-of-life HP product return and recycling programs in many geographic areas. To recycle your product, please go to: http://www.hp.com/go/reuse-recycle or contact your nearest HP sales office. Products returned to HP will be recycled, recovered or disposed of in a responsible manner.

The EU WEEE directive (2002/95/EC) requires manufacturers to provide treatment information for each product type for use by treatment facilities. This information (product disassembly instructions) is posted on the Hewlett Packard web site at: http://www.hp.com/go/recyclers.



System Technical Specifications

	These instructions may be used by recyclers and other WEEE treatment facilities as well as HP OEM customers who integrate and re-sell HP equipment.
HP, Inc. Corporate Environmental	For more information about HP's commitment to the environment:
Information	Global Citizenship Report
	http://www.hp.com/hpinfo/globalcitizenship/gcreport/index.html
	Eco-label certifications
	http://www8.hp.com/us/en/hp-information/environment/ecolabels.html
	ISO 14001 certificates:
	http://h20195.www2.hp.com/V2/GetDocument.aspx?docname=c04755842
	and
	http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/cert.pdf
footnotes	 Percentage of ocean-bound plastic contained in each component varies by product Recycled plastic content percentage is based on the definition set in the IEEE 1680.1-2018 standard.
	 External power supplies, WWAN modules, power cords, cables and peripherals excluded. 100% outer box packaging and corrugated cushions made from sustainably sourced certified and recycled fibers.
	• Fiber cushions made from 100% recycled wood fiber and organic materials.
	Plastic cushions are made from >90% recycled plastic.
	• Recycled metal is expressed as a percentage of the total weight of the metal according to ISO 14021 definitions for metal parts over 25 grams.

Manageability

Industry Standard Specifications Intel® Active Management Technology (AMT)

This product meets the following industry standard specifications for manageability functionality: • DASH 1.1 (via Intel[®] LAN on motherboard)

Intel® Active Management Intel® Active Management Technology (AMT) 15.20

An advanced set of remote management features and functionality providing IT administrators the latest and most effective tools to remotely discover, heal, and protect networked client systems regardless of the system's health or power state. AMT 15.20 includes the following advanced management functions:

- Power Management (on, off, reset, graceful shutdown, sleep and hibernate)

 Support in Max Power Savings (Shutdown and Hibernate Modes)
- Hardware Inventory (includes BIOS and firmware revisions)
- Hardware Alerting
- Agent Presence
- System Defense Filters
- Serial Over LAN (SOL)
- USB Redirect (Media Redirection)
- ME Wake-on-LAN (WOL), even with Maximum Power Savings Enabled
- DASH 1.2 compliance
- IPv6 Support
- Fast Call for Help a client inside or outside the firewall may initiate a call for help via BIOS screen, periodic connections, or alert triggered connection
- Remote Scheduled Maintenance pre-schedule when the system connects to the IT or service provider console for maintenance.
- Remote Alerts automatically alert IT or service provider if issues arise
- Access Monitor Provides oversight into Intel® AMT actions to support security requirements



System Technical Specifications

- PC Alarm Clock
- Microsoft NAP Support
- Host Base set-up and configuration
- Management Engine (ME) firmware roll back
- Local Time Sync to UTC
- Remote Memory Dump Command Creates memory dump for debug

Intel® vPro™ Technology Yes, when configured with an Intel[®] vPro[™] supporting processor.

Technical Specifications - Stable & Consistent Offerings

Stable & Consistent Offerings

Global Series SKUs	As part of its commitment to hardware, software, and solution innovation, HP is proud to introduce this breakthrough platform configuration stability to HP Workstation customers. HP Stable & Consistent Offerings are built on the foundation of a carefully chosen set of hardware and software designed and tested to work with all HP Z Workstation platforms through their end of life. These components and their corresponding HP Workstation platform compatibility are outlined in this section.			
Stable & Consistent Offerings	HP Stable & Consistent Offerings are available worldwide to all HP Workstation customers-no special programs, no additional cost-no kidding. Simply select your hardware and software components when you customize your HP Workstation and be assured that you'll be able to buy th same configuration throughout the lifecycle of the product.			
Processors	Product #	Offering		
	3F4D7AV	Intel Xeon 5415+		
	3F4D3AV	Intel Xeon 4410Y		
Graphics	Product #	Offering		
	6Z325AV	NVIDIA Long-Life T1000E		
	6Z319AV	NVIDIA Long-Life RTX A2000E		
	6Z321AV	NVIDIA Long-Life RTX A4000E		
	6B4J4AV	AMD Radeon RX 6400		
	3F2W5AV	AMD Radeon Pro 6600		
Storage	Product #	Offering		
	3F3A6AV	Z Turbo 1TB PCIe-4x4 2280 TLC M.2 Solid State Drive		
	3F4E6AV	1TB 7200RPM SATA 3.5in Enterprise		



Technical Specifications - Storage Drives

STORAGE/HARD DRIVES

Performance PCIe SSDs	Z Turbo 512GB	Capacity	512GB		
for HP Workstations	2280 PCIe-4x4 TLC SSD	Protocol	PCle		
		Form Factor	M.2		
		Controller	NVMe		
		NAND Type	3D TLC		
		Endurance	300TBW (TB Written)		
		Reliability	1.5M hours		
			Rated for 24/7/365 operation	No	
		Interface	PCI Express 4.0 x4 elec	trical	
			Operating Temperature	32° to 158° F (0° to 70°	C)
			Performance	Sequential Read	up to 6400MB/s*
			Sequential Write	up to 3400MB/s*	
			Random Read	up to 600K IOPS*	
			Random Write	up to 600K IOPS*	

*Actual performance may vary.

NOTE: For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36GB of system disk (for Windows) is reserved for system recovery software.

Z Turbo 512GB	Capacity	512GB		
2280 PCIe-4x4 SED	Protocol	PCIe		
OPAL2 TLC M.2 SSD	Form Factor	M.2		
	Controller	NVMe		
	NAND Type	3D TLC		
	Endurance	300TBW (TB Written)		
	Reliability	1.5M hours		
	Rated for 24/7/365 operation	No		
	Interface	PCI Express 4.0 x4 elec	trical	
	Operating Temperature	32° to 158° F (0° to 70°	C)	
	Performance	Sequential Read	up to 6400MB/s*	
		Sequential Write	up to 3400MB/s*	
		Random Read	up to 600K IOPS*	
		Random Write	up to 600K IOPS*	
	Self-Encrypting Drive Support	OPAL 2		
*Actual performance may	varv			

*Actual performance may vary.

NOTE: For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36GB of system disk (for Windows) is reserved for system recovery software.

Z Turbo 1 TB	Capacity	1TB
2280 PCIe-4x4 SED	Protocol	PCIe
OPAL2 TLC M.2 SSD	Form Factor	M.2
	Controller	NVMe
	NAND Type	3D TLC
	Endurance	400TBW (TB Written)
	Reliability	1.5M hours



Technical Specifications - Storage Drives

Rated for 24/7/365 operation	No		
Interface	PCI Express 4.0 x4 electrical		
Operating Temperature	32° to 158° F (0° to 70° C)		
Performance	Sequential Read	up to 6500MB/s*	
	Sequential Write	up to 5000MB/s*	
	Random Read	up to 800K IOPS*	
	Random Write	up to 800K IOPS*	
Self-Encrypting Drive Support	OPAL 2		

*Actual performance may vary.

NOTE: For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36GB of system disk (for Windows) is reserved for system recovery software.

Z Turbo 1TB	Capacity	1TB	
2280 PCIe-4x4 TLC SSD	Protocol	PCIe	
	Form Factor	M.2	
	Controller	NVMe	
	NAND Type	3D TLC	
	Endurance	400TBW (TB Written)	
	Reliability	1.5M hours	
	Rated for 24/7/365 operation	Νο	
	Interface	PCI Express 4.0 x4 elect	rical
	Operating Temperature	32° to 158° F (0° to 70°	C)
	Performance	Sequential Read	up to 6500MB/s*
		Sequential Write	up to 5000MB/s*
		Random Read	up to 800K IOPS*
		Random Write	up to 800K IOPS*

*Actual performance may vary.

NOTE: For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36GB of system disk (for Windows) is reserved for system recovery software.

Z Turbo 1TB	Capacity	1TB	
2280 PCIe-4x4 TLC SSD	Protocol	PCle	
	Form Factor	M.2	
	Controller	NVMe	
	NAND Type	3D TLC	
	Endurance	400TBW (TB Written)	
	Reliability	1.5M hours	
	Rated for 24/7/365 operation	No	
	Interface	PCI Express 4.0 x4 elec	trical
	Operating Temperature	32° to 158° F (0° to 70°	C)
	Performance	Sequential Read	up to 6500MB/s*
		Sequential Write	up to 5000MB/s*
		Random Read	up to 800K IOPS*
		Random Write	up to 800K IOPS*



*Actual performance may vary. NOTE: For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36GB of system disk (for Windows) is reserved for system recovery software.

Z Turbo 2TB	Capacity	2TB	
2280 PCIe-4x4 SED	Protocol	PCIe	
OPAL2 TLC M.2 SSD	Form Factor	M.2	
	Controller	NVMe	
	NAND Type	3D TLC	
	Endurance	500TBW (TB Written)	
	Reliability	1.5M hours	
	Rated for 24/7/365	No	
	operation		
	Interface	PCI Express 4.0 x4 elect	rical
	Operating Temperature	32° to 158° F (0° to 70°	C)
	Performance	Sequential Read	up to 6500MB/s*
		Sequential Write	up to 5000MB/s*
		Random Read	up to 800K IOPS*
		Random Write	up to 800K IOPS*
	Self-Encrypting Drive Support	OPAL 2	

*Actual performance may vary.

NOTE: For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36GB of system disk (for Windows) is reserved for system recovery software.

Z Turbo 2TB	Capacity	2TB	
2280 PCIe-4x4 TLC SSD	Protocol	PCIe	
	Form Factor	M.2	
	Controller	NVMe	
	NAND Type	3D TLC	
	Endurance	500TBW (TB Written)	
	Reliability	1.5M hours	
	Rated for 24/7/365 operation	No	
	Interface	PCI Express 4.0 x4 ele	ctrical
	Operating Temperature	32° to 158° F (0° to 70	о° С)
	Performance	Sequential Read	up to 6500MB/s*
		Sequential Write	up to 5000MB/s*
		Random Read	up to 800K IOPS*
		Random Write	up to 800K IOPS*
*Actual performance may	vary. 3 = 1 hillion bytes. TB = 1 trillion	n hytes. Actual formatted	ranacity is less. Un to 366

Capacity	4TB
Protocol	PCle
Form Factor	M.2
Controller	NVMe
NAND Type	3D TLC
	Protocol Form Factor Controller



Endurance	600TBW (TB Written)		
Reliability	1.5M hours		
Rated for 24/7/365 operation	No		
Interface	PCI Express 4.0 x4 elect	rical	
Operating Temperature	32° to 158° F (0° to 70° C)		
Performance	Sequential Read	up to 6500MB/s*	
	Sequential Write	up to 5000MB/s*	
	Random Read	up to 700K IOPS*	
	Random Write	up to 700K IOPS*	

*Actual performance may vary.

NOTE: For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36GB of system disk (for Windows) is reserved for system recovery software.

Z Turbo 4TB	Capacity	4TB	
2280 PCIe-4x4 SED	Protocol	PCIe	
OPAL2 TLC M.2 SSD	Form Factor	M.2	
	Controller	NVMe	
	NAND Type	3D TLC	
	Endurance	600TBW (TB Written)	
	Reliability	1.5M hours	
	Rated for 24/7/365 operation	No	
	Interface	PCI Express 4.0 x4 elect	rical
	Operating Temperature	32° to 158° F (0° to 70°	C)
	Performance	Sequential Read	up to 6500MB/s*
		Sequential Write	up to 5000MB/s*
		Random Read	up to 700K IOPS*
		Random Write	up to 700K IOPS*
	Self-Encrypting Drive Support	OPAL 2	

*Actual performance may vary.

Performance PCIe SSDs HI	P Z Turbo Drive Dual	Capacity	512GB	
for HP Dual Pro Carrier Pi	ro 512GB SSD	Protocol	PCIe	
		Form Factor	M.2	
		Controller	NVMe	
		NAND Type	3D TLC	
		Endurance	300TBW (TB Written)	
		Reliability	1.5M hours	
		Rated for 24/7/365 operation	No	
		Interface	PCI Express 4.0 x4 elect	trical
		Operating Temperature	32° to 158° F (0° to 70°	C)
		Performance	Sequential Read	up to 6400MB/s*



Sequential Write	up to 3400MB/s*
Random Read	up to 600K IOPS*
Random Write	up to 600K IOPS*

*Actual performance may vary.

NOTE: For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36GB of system disk (for Windows) is reserved for system recovery software.

HP Z Turbo Drive Dual	Capacity	1TB	
Pro 1TB SSD	Protocol	PCIe	
	Form Factor	M.2	
	Controller	NVMe	
	NAND Type	3D TLC	
	Endurance	400TBW (TB Written)	
	Reliability	1.5M hours	
	Rated for 24/7/365 operation	No	
	Interface	PCI Express 4.0 x4 elect	rical
	Operating Temperature	32° to 158° F (0° to 70°	C)
	Performance	Sequential Read	up to 6500MB/s*
		Sequential Write	up to 5000MB/s*
		Random Read	up to 800K IOPS*
		Random Write	up to 800K IOPS*

*Actual performance may vary.

NOTE: For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36GB of system disk (for Windows) is reserved for system recovery software.

•			
HP Z Turbo Drive Dual	Capacity	2TB	
Pro 2TB SSD	Protocol	PCIe	
	Form Factor	M.2	
	Controller	NVMe	
	NAND Type	3D TLC	
	Endurance	500TBW (TB Written)	
	Reliability	1.5M hours	
	Rated for 24/7/365 operation	No	
	Interface	PCI Express 4.0 x4 elect	trical
	Operating Temperature	32° to 158° F (0° to 70°	C)
	Performance	Sequential Read	up to 6500MB/s*
		Sequential Write	up to 5000MB/s*
		Random Read	up to 800K IOPS*
		Random Write	up to 800K IOPS*

*Actual performance may vary.

HP Z Turbo Drive	Capacity	4TB
Dual Pro 4TB SSD	Protocol	PCle
	Form Factor	M.2
	Controller	NVMe



NAND T	уре	3D TLC	
Endura	nce	500TBW (TB Written)	
Reliabi	lity	1.5M hours	
Rated f operati	or 24/7/365 on	No	
Interfa	ce	PCI Express 4.0 x4 elect	trical
Operati	ing Temperature	32° to 158° F (0° to 70°	C)
Perfor	nance	Sequential Read	up to 6500MB/s*
		Sequential Write	up to 5000MB/s*
		Random Read	up to 800K IOPS*
		Random Write	up to 800K IOPS*
*Actual performance may vary. NOTE: For storage drives, GB = 1 billior system disk (for Windows) is reserved			apacity is less. Up to 36GB of
1TB 7200RPM SATA 3.5in Capacit	.y	1TB	

SATA Hard Drives	1TB 7200RPM SATA 3.5in	Capacity	1TB	
for HP Workstations	Enterprise HDD	Protocol	SATA	
		Form Factor	3.5"	
		Controller	AHCI	
		Reliability	2.0M hours	
		Rated Power On Hours	8760/yr	
		Annualized Failure Rate (based on Rated POH)	<0.62%	
		Rated for 24/7/365 operation	YES	
		Height	1 in; 2.54 cm	
		Width	Media Diameter	3.5 in; 8.9 cm
			Physical Size	4 in; 10.17 cm
		Interface	Serial ATA (6.0Gb/s),	NCQ enabled
		Synchronous Transfer Rate (Maximum)	Up to 600MB/s *	
		Buffer	128MB	
		Cache	Adaptive	
		Seek Time (typical reads,	Single Track	0.32 ms *
		includes controller	Average	7.45 ms *
		overhead, including settling)	Full Stroke	14.2 ms *
		Rotational Speed	7,200 rpm	
		Logical Blocks	1,953,525,168	
		Operating Temperature	41° to 131° F (5° to 5	5° C)
		Performance	Sequential Read	up to 226MB/s*
			Sequential Write	up to 226MB/s*

of system disk (for Windows) is reserved for system recovery software.

2TB 7200RPM SATA 3.5in	Capacity	2TB
Enterprise HDD	Protocol	SATA



Form Factor	3.5"	
Controller	AHCI	
Reliability	2.0M hours	
Rated Power On Hours	8760/yr	
Annualized Failure Rate (based on Rated POH)	<0.62%	
Rated for 24/7/365 operation	YES	
Height	1 in; 2.54 cm	
Width	Media Diameter	3.5 in; 8.9 cm
	Physical Size	4 in; 10.17 cm
Interface	Serial ATA (6.0Gb/s), NC	Q enabled
Synchronous Transfer Rate (Maximum)	Up to 600MB/s *	
Buffer	128MB	
Cache	Adaptive	
Seek Time (typical reads,	Single Track	0.7 ms *
includes controller	Average	8.5 ms *
overhead, including settling)	Full Stroke	15.7 ms *
Rotational Speed	7,200 rpm	
Logical Blocks	3,907,029,168	
Operating Temperature	41° to 131° F (5° to 55° (C)
Performance	Sequential Read	up to 226MB/s*
	Sequential Write	up to 226MB/s*

*Actual performance may vary.

4TB 7200 RPM SATA 3.5in	Capacity	4TB	
Enterprise HDD	Protocol	SATA	
	Form Factor	3.5"	
	Controller	AHCI	
	Reliability	2.0M hours	
	Rated Power On Hours	8760/yr	
	Annualized Failure Rate (based on Rated POH)	<0.62%	
	Rated for 24/7/365 operation	YES	
	Height	1 in; 2.54 cm	
	Width	Media Diameter	3.5 in; 8.9 cm
		Physical Size	4 in; 10.17 cm
	Interface	Serial ATA (6.0Gb/s), NO	Q enabled
	Synchronous Transfer Rate (Maximum)	Up to 600MB/s *	
	Buffer	256MB	
	Cache	Adaptive	
		Single Track	0.7 ms *



Seek Time (typical reads, includes controller overhead, including settling)	Average Full Stroke	8.5 ms * 15.7 ms *
Rotational Speed	7,200 rpm	
Logical Blocks	7,814,037,168	
Operating Temperature	41° to 131° F (5° to 55°	C)
Performance	Sequential Read	up to 226MB/s*
	Sequential Write	up to 226MB/s*

*Actual performance may vary.

NOTE: For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36GB of system disk (for Windows) is reserved for system recovery software.

8TB 7200RPM SATA 3.5in	Capacity	8TB	
Enterprise HDD	Protocol	SATA	
	Form Factor	3.5"	
	Controller	AHCI	
	Reliability	2.0M hours	
	Rated Power On Hours	8760/yr	
	Annualized Failure Rate (based on Rated POH)	<0.62%	
	Rated for 24/7/365 operation	YES	
	Height	1 in; 2.54 cm	
	Width	Media Diameter	3.5 in; 8.9 cm
		Physical Size	4 in; 10.17 cm
	Interface	Serial ATA (6.0Gb/s), NC	Q enabled
	Synchronous Transfer Rate (Maximum)	Up to 600MB/s *	
	Buffer	256MB	
	Cache	Adaptive	
	Seek Time (typical reads,	Single Track	0.7 ms *
	includes controller	Average	8.5 ms *
	overhead, including settling)	Full Stroke	15.7 ms *
	Rotational Speed	7,200 rpm	
	Logical Blocks	15,628,053,168	
	Operating Temperature	41° to 140° F (5° to 60°	C)
	Performance	Sequential Read	up to 226MB/s*
		Sequential Write	up to 226MB/s*

*Actual performance may vary.

12TB 7200 RPM SATA-6G	Capacity	12TB
3.5in Enterprise HDD	Protocol	SATA
	Form Factor	3.5"
	Controller	AHCI
	Reliability	2.0M hours



Rated Power On Hours	8760/yr	
Annualized Failure Rate (based on Rated POH)	<0.62%	
Rated for 24/7/365 operation	YES	
Height	1 in; 2.54 cm	
Width	Media Diameter	3.5 in; 8.9 cm
	Physical Size	4 in; 10.17 cm
Interface	Serial ATA (6.0Gb/s), N	CQ enabled
Synchronous Transfer Rate (Maximum)	Up to 600MB/s *	
Buffer	256MB	
Cache	Adaptive	
Seek Time (typical reads,	Single Track	0.7 ms *
includes controller	Average	8.5 ms *
overhead, including settling)	Full Stroke	15.7 ms *
Rotational Speed	7,200 rpm	
Logical Blocks	23,437,770,752	
Operating Temperature	41° to 140° F (5° to 60°	C)
Performance	Sequential Read	up to 226MB/s*
	Sequential Write	up to 226MB/s*

*Actual performance may vary.



GRAPHICS

NVIDIA® RTX™ 6000 Ada 48GB	Form Factor	Full-Height Dual Slot (4.4" Height x 10.5" Length) Weight: 1230 grams / 2.71 lbs (with extender)
	Max Power Consumption	Power: 300 Watts Cooling: Active
	GPU Memory	48GB GDDR6 memory ECC Memory Bandwidth: Up to 960 GB/s Memory Width: 384 bits
	Connectors	4x DisplayPort 1.4a Quadro Sync II connector Stereo Sync Requires CEM 5.0 16-pin auxiliary power adapter
	Maximum Resolution	7680x4320 @ 120Hz
	Bus Type	PCI Express 4.0 x16
	Available Graphics Drivers	Windows 11 Windows 10 Linux® 64-bit
NVIDIA® RTX™ A6000 48GB	Form Factor	Full-Height Dual Slot (4.4" Height x 10.5" Length) Weight: 1230 grams / 2.71 lbs (with extender)
	Max Power Consumption	Power: 300 Watts Cooling: Active
	GPU Memory	48GB GDDR6 memory ECC optional Memory Bandwidth: Up to 768 GB/s Memory Width: 384 bit
	Connectors	4x DisplayPort 1.4a Quadro Sync II connector NVLink® Stereo Sync Requires 8-pin auxiliary power
	Maximum Resolution	7680x4320@120Hz
	Bus Type	PCI Express 4.0 x16
	Available Graphics Drivers	Windows 11 Windows 10 Linux® 64-bit
NVIDIA® RTX™ A5000 24GB	Form Factor	Full-Height Dual Slot (4.4" Height x 10.5" Length) Weight: 1049 grams + 80 grams extender
	Max Power Consumption	Power: 230W Cooling: Active
	GPU Memory	24GB GDDR6 memory ECC optional Memory Bandwidth: Up to 768 GB/s Memory Width: 384 bit
	Connectors	4x DisplayPort 1.4a Quadro Sync II connector NVLink®



	Maximum Resolution Bus Type Available Graphics Drivers	Stereo Sync Requires 8-pin auxiliary power 7680x4320 @ 120Hz PCI Express 4.0 x16 Windows 11 Windows 10 Linux® 64-bit
NVIDIA® RTX A4500 20GB	Form Factor	Full-Height Dual Slot (4.4" Height x 10.5" Length) Weight: 1049 grams + 80 grams extender
	Max Power Consumption	Power: 200W Cooling: Active
	GPU Memory	20GB GDDR6 memory Memory Bandwidth: Up to 640 GB/s Memory Width: 320 bit
	Connectors	4x DisplayPort 1.4a Quadro Sync II connector NVLink® Stereo Sync Requires 8-pin auxiliary power
	Maximum Resolution	7680x4320 @ 120Hz
	Bus Type	PCI Express 4.0 x16
	Available Graphics Drivers	Windows 11 Windows 10 Linux® 64-bit
NVIDIA® RTX A4000 16GB	Form Factor	Full-Height Single Slot (4.4" Height x 9.5" Length) Weight: 500 grams
	Max Power Consumption	Power: 140W Cooling: Active
	GPU Memory	16GB GDDR6 memory Memory Bandwidth: Up to 448 GB/s Memory Width: 256 bit
	Connectors	4x DisplayPort 1.4a Quadro Sync II connector Stereo Sync Requires 6-pin auxiliary power
	Maximum Resolution	7680x4320@120Hz
	Bus Type	PCI Express 4.0 x16
	Available Graphics Drivers	Windows 11 Windows 10 Linux® 64-bit
NVIDIA® Long-Life RTX A4000E 16GB	Form Factor	Full-Height Single Slot (4.4" Height x 9.5" Length) Weight: 500 grams
	Max Power Consumption	Power: 140W Cooling: Active



	Connectors Maximum Resolution Bus Type Available Graphics Drivers Form Factor	Memory Width: 256 bit 4x DisplayPort 1.4a Quadro Sync II connector Stereo Sync Requires 6-pin auxiliary power 7680x4320 @ 120Hz PCI Express 4.0 x16 Windows 11 Windows 10 Linux® 64-bit
 	Bus Type Available Graphics Drivers	PCI Express 4.0 x16 Windows 11 Windows 10 Linux® 64-bit
	Available Graphics Drivers	Windows 11 Windows 10 Linux [®] 64-bit
	Drivers	Windows 10 Linux® 64-bit
NVIDIA® RTX A2000 12GB	Form Factor	Half Height Dual Clat (2.712"
		Half-Height Dual Slot (2.713" Height x 6.6" Length) Weight: 306 grams
I	Max Power Consumption	Power: 70W Cooling: Active
(GPU Memory	12GB GDDR6 memory Memory Bandwidth: Up to 288 GB/s Memory Width: 192 bit
(Connectors	4x mini-DisplayPort 1.4a
I	Maximum Resolution	7680x4320 @ 120Hz
I	Bus Type	PCI Express 4.0 x16
	Available Graphics Drivers	Windows 11 Windows 10 Linux® 64-bit
NVIDIA® Long-Life RTX I A2000E 12GB	Form Factor	Half-Height Dual Slot (2.713" Height x 6.6" Length) Weight: 306 grams
ı	Max Power Consumption	Power: 70W Cooling: Active
	GPU Memory	12GB GDDR6 memory Memory Bandwidth: Up to 288 GB/s Memory Width: 192 bit
(Connectors	4x mini-DisplayPort 1.4a
I	Maximum Resolution	7680x4320 @ 120Hz
ſ	Bus Type	PCI Express 4.0 x16
	Available Graphics Drivers	Windows 11 Windows 10 Linux® 64-bit
NVIDIA® T1000 8GB	Form Factor	Half-Height Single Slot (2.713" Height x 6.137" Length) Weight: 132.6 grams
I	Max Power Consumption	Power: 50W Cooling: Active



	GPU Memory	8GB GDDR6 memory Memory Bandwidth: Up to 160 GB/s Memory Width: 128 bit
	Connectors	4x mini-DisplayPort 1.4a
	Maximum Resolution	7680x4320 @ 120Hz
	Bus Type	PCI Express 3.0 x16
	Available Graphics Drivers	Windows 11 Windows 10 Linux® 64-bit
NVIDIA® Long-Life T1000E 8GB	Form Factor	Half-Height Single Slot (2.713" Height x 6.137" Length) Weight: 132.6 grams
	Max Power Consumption	Power: 50W Cooling: Active
	GPU Memory	8GB GDDR6 memory Memory Bandwidth: Up to 160 GB/s Memory Width: 128 bit
	Connectors	4x mini-DisplayPort 1.4a
	Maximum Resolution	7680x4320 @ 120Hz
	Bus Type	PCI Express 3.0 x16
	Available Graphics Drivers	Windows 11 Windows 10 Linux® 64-bit
NVIDIA® T1000 4GB	Form Factor	Half-Height Single Slot (2.713" Height x 6.137" Length) Weight: 132.6 grams
	Max Power Consumption	Power: 50W Cooling: Active
	GPU Memory	4GB GDDR6 memory Memory Bandwidth: Up to 160 GB/s Memory Width: 128 bit
	Connectors	4x mini-DisplayPort 1.4a
	Maximum Resolution	7680x4320 @ 120Hz
	Bus Type	PCI Express 3.0 x16
	Available Graphics Drivers	Windows 11 Windows 10 Linux® 64-bit
NVIDIA® T400 4GB	Form Factor	Half-Height Single Slot (2.713" Height x 6.137" Length) Weight: 123.5 grams
	Max Power Consumption	Power: 30W
	Hux I ower consumption	Cooling: Active
	GPU Memory	Cooling: Active 4GB GDDR6 memory Memory Bandwidth: Up to 80 GB/s Memory Width: 64 bit

QuickSpecs

	Maximum Resolution Bus Type Available Graphics Drivers	7680x4320@120Hz PCI Express 3.0 x16 Windows 11 Windows 10 Linux® 64-bit
AMD® Radeon™ Pro W6800 32GB	Form Factor	Full-Height Dual Slot (4.4" Height x 10.5" Length) Weight: 850 grams
	Max Power Consumption	Power: 261W Cooling: Active
	GPU Memory	32GB GDDR6 memory Memory Bandwidth: Up to 512 GB/s Memory Width: 256 bit
	Connectors	6x mini-DisplayPort 1.4 Requires 8-pin+6-pin auxiliary power
	Maximum Resolution	7680x4320 @ 60Hz
	Bus Type	PCI Express 4.0 x16
	Available Graphics Drivers	Windows 11 Windows 10 Linux® 64-bit
AMD® Radeon™ Pro W6600 8GB	Form Factor	Full-Height Single Slot (4.38" Height x 9.50" Length) Weight: 132.6 grams
	Max Power Consumption	Power: 122W Cooling: Active
	GPU Memory	8GB GDDR6 memory Memory Bandwidth: Up to 224 GB/s Memory Width: 128 bit
	Connectors	4x DisplayPort 1.4 Requires 6-pin auxiliary power
	Maximum Resolution	7680x4320@60Hz
	Bus Type	PCI Express 4.0 x16 (x8 electrical)
	Available Graphics Drivers	Windows 11 Windows 10 Linux® 64-bit
AMD® Radeon™ RX 6400 4GB	Form Factor	Half-Height Single Slot (4.4" Height x 10.5" Length) Weight: 155 grams
	Max Power Consumption	Power: 50W Cooling: Active
	GPU Memory	4GB GDDR6 memory Memory Bandwidth: Memory Width:
	Connectors	1x DisplayPort 1.4a 1x HDMI
	Maximum Resolution	7680x4320 @ 60Hz
	Bus Type	PCI Express 4.0 x4



QuickSpecs

Technical Specifications - Graphics

	Available Graphics Drivers	Windows 11 Windows 10 Linux® 64-bit
Intel [®] Arc Pro A40 6GB	Form Factor	Half-Height Single Slot (2.7" Height x 6.6" Length) Weight: 220 grams
	Max Power Consumption	Power: 50W Cooling: Active
	GPU Memory	6GB GDDR6 memory Memory Bandwidth: 192GB Memory Width: 96 bit
	Connectors	4x mini- DisplayPort 1.4
	Maximum Resolution	7680x4320 @ 60Hz
	Bus Type	PCI Express 4.0 x8
	Available Graphics Drivers	Windows 11 Windows 10

Notes for all graphics cards:

- Some graphics and GPU compute cards can consume a great deal of power, thus combinations of cards with other components may exceed a particular power supply's output capability.
- Some graphics and GPU compute cards require supplemental power cables.
- Not all chassis/PSU configurations have enough supplemental power cables of the correct type for all graphics configurations.

Refer to the Power Supply section within Overview for more information.

OPTICAL AND REMOVABLE STORAGE

HP 9.5mm Slim Blu-Ray Writer	Description Mounting Orientation Interface Type Dimensions (WxHxD) Supported Media Types	9.5mm height, tray-load Either horizontal or vertical SATA/ATAPI 128 x 9.5 x 127mm BD-ROM BD-R BD-RE DVD+R DVD+R DVD+RW DVD+R DL DVD-R DL DVD-R DVD-RW CD-R CD-R	
	Disc Capacity	DVD-ROM Blu-ray Full Stroke DVD	8.5 GB DL or 4.7 GB standard 25 GB (single-layer) 50 GB (dual-layer) 100/128 GB (BDXL) < 230 ms (seek)



	Full Stroke CD	< 220 ms (seek)	
	Blu-ray	< 230 ms (seek) (Full Stroke Blu-ray)	
	-		
	Startup Time	(Time to drive ready from tray loading) BD-ROM (SL/DL) 25S / 28S BD-R (SL/DL) 25S / 28S BD-RE (SL/DL) 25S / 28S DVD-ROM (SL/DL) 18S / 18S DVD-R (SL/DL) 25S / 25S DVD-RW 25S DVD+R (SL/DL) 25S / 25S DVD+R (SL/DL) 25S / 25S DVD+R (SL/DL) 25S / 25S DVD+RW 25S DVD+RW 25S DVD+RW 25S DVD-ROM 15S	
Maximum Data Transfer Rates	CD ROM Read	CD-ROM, CD-R Up to 24X CD-RW Up to 24X	
	DVD ROM Read	DVD+RW Up to 8X DVD-RW Up to 8X DVD+R DL Up to 8X DVD-R DL Up to 8X DVD-ROM Up to 8X DVD-ROM DL Up to 8X DVD+R Up to 8X DVD-R Up to 8X	
	Blu-ray	BD-ROM Up to 6X BD-ROM DL Up to 6X BD-R Up to 6X BD-R DL Up to 6X BD-R Up to 6X BD-R SL/DL Up to 6X	
Power	Source	SATA DC power receptacle	
	DC Power Requirements	5 VDC ± 5%-100 mV ripple p-p	
	DC Current	5 VDC -900 mA typical, 2000mA maximum	
Operating Environmental		41° to 122° F (5° to 50° C)	
(all conditions non-	Relative Humidity	10% to 80%	
condensing)	Maximum Wet Bulb Temperature	84° F (29° C)	
Operating Systems Supported	Windows 11, Windows 10, Windows 7 Professional 64-bit, Red Hat® Enterprise Linux® (RHEL) 8, 9 Desktop/Workstation SUSE Linux® Enterprise Desktop 15 Ubuntu 20.04, 22.04 LTS No driver is required for this device. Native support is provided by the operating system.		
Kit Contents			



hD

Technical Specifications - Graphics

require a DVI or HDMI digital connection and your display may require HDCP support. HD-DVD movies cannot be played on this workstation.

NOTE: HD-DVD disks cannot be played on the DVD-ROM drive. No support for DVD-RAM. Actual speeds may vary. Don't copy copyright-protected materials. Double Layer discs can store more data than single layer discs. Discs burned with this drive may not be compatible with many existing single-layer DVD drives and players. Flawless playback on all systems is not guaranteed.

Writer Mounting Orientation Interface Type Either horizontal or vertical Dimensions (WXHXD) SATA/ATAPI Dimensions (WXHXD) 128 x 9.5 x 127mm Supported Media Types DVD+R DVD-R DL DVD-R RUL DVD-R DL DVD-R RUL DVD-R DL DVD-RW DVD-R VC CD-RW DVD-R MU S45 GB DL or 4.7 GB standard Full Stroke DVD < 200 ms (seek) Maximum Data Transfer CD ROM Read CD-RW Up to 24X DVD ROM Read DVD-RW Up to 8X DVD-RW Up to 8X DVD-R DL DVD-ROM Read DVD-RW Up to 8X DVD-R DL DVD-ROM Read DVD-RW Up to 8X DVD-R DL Up to 8X DVD-RW Up to 8X DVD-ROM Up to 8X DVD-R DL Up to 8X DVD-ROM DL Up to 8X DVD-ROM Up to 8X DVD-R DL Up to 8X DVD-R DL Up to 8X DVD-R DL Up to 8X DVD-R Up to 8X DVD-R UP to 8X DVD-R UP to 8X DVD-R Up to 8X DVD-R Up to 8X DVD-R UP to 8X DVD-R Up to 8X DVD-R UP to 8X DVD-R UP to 8X DVD-R UP to 8X DVD-R UP to 8X DVD-R UP to 8X <tr< th=""><th></th><th></th><th></th><th></th></tr<>				
Interface Type SATA/ATAPI Dimensions (WXHXD) 128 x 9.5 x 127mm Supported Media Types DVD-R DVD-R DUD-R DVD-R DL DVD-R DL DVD-R DL DVD-R DVD-R DUD-R DVD-R DL DVD-R DVD-R DL DVD-R DVD-R DUD-R DVD-R DL DVD-R DVD-R DL Seekl Full Stroke DVD < 200 ms (seek)		Description		
Dimensions128 x 9.5 x 127mmSupported Media TypesDVD+R DVD+RV DVD+RDL DVD-R DL 	writer	-		
Supported Media Types DVD+R W DVD+R NU DVD+R DL DVD-R DL Eutil Stroke DVD Rates8.5 GB DL or 4.7 GB standard Stroke DVD Disc CapacityDVD-ROM Full Stroke DVD Full Stroke DVD R LU pto 24X CD-R W Up to 24X CD-RW Up to 24X CD-RW Up to 24X DVD-RDL Up to 8X DVD-RDL Up to 8X DVD-RDL Up to 8X DVD-RDU Up to 8X DVD-R DL Up to 8X DVD-R DL Up to 8X DVD-R DU to 10 to 8X DVD-R Up to 8X DVD-R DU to 10 to 122° F (5° to 50° C) (fall conditions non- condensing)Qerating SystemWindows 11, Windows 10, Windows 7 Professional 64-bit, Windows Vista Business 64°, Windows 7 Professional 64-bit, Windows Vista Business 64°, Windows 7 Professional 64-bit, Windows SUSE Linux® Enterprise Linux® (RHEU 8, 9 Desktop/Workstation SUSE Linux® Enterprise Linux® (RHEU 8, 9 Desktop/Workstation SUSE Linux® Enterprise Linux® (RHEU 8, 9 Desktop/Workstation SUSE Linux® Enterprise Desktop I S Ubuntu 20.04, 22.04 LTS		•••		
DVD-RW DVD-RD DVD-RD DVD-RD DVD-RD DVD-RDDVD-RD DVD-RD DVD-RW CD-RWDisc CapacityDVD-ROM CPR CD-RW8.5 GB DL or 4.7 GB standard Stoke ND Full Stroke DVD Full Stroke DVDMaximum Data Transfer RatesCD ROM ReadDVD-ROM, CD-R Up to 24X CD-RW Up to 24XMaximum Data Transfer RatesCD ROM ReadDVD-ROM, CD-R Up to 24X CD-RW Up to 24XPowerSource DC CorrentSATA DC power receptacle DC Power Requirements S VDC + SW DVD-R DL Up to 8X DVD-R Up to 8X DV		,		
DVD-R DL DVD-R DVD-RW CD-RW8.5 GB DL or 4.7 GB standard CD-RWDisc CapacityDVD-ROM8.5 GB DL or 4.7 GB standard Full Stroke DVDPaul Stroke DVD< 200 ms (seek)		Supported Media Types		
DVD-R DL DVD-R DVD-RW CD-R CD-RWS.5 GB DL or 4.7 GB standard CD-RWDisc CapacityDVD-ROM Full Stroke DVD8.5 GB DL or 4.7 GB standard Full Stroke DVDMaximum Data Transfer RatesCD ROM ReadCD-ROM, CD-R Up to 24X CD-RW Up to 24X CD-RW Up to 24X CD-RW Up to 8X DVD-ROM DU-ROM Up to 8X DVD-ROM DU to 8X DVD-ROM LUp to 8X DVD-ROM TO ROM ANXING DVD-ROM TO ROM ANXING DVD-ROM TO ROM ANXING DVD-ROM TO ROM ANXING DVD-ROM TO ROM ANXIN				
DUD-RW CD-R CD-RWS.5 GB DL or 4.7 GB standard Full Stroke DVD\$ 200 ms (seek) Full Stroke DVDMaximum Data Transfer RatesCD ROM ReadCD-ROM, CD-R Up to 24X CD ROM ReadCD-ROW, Up to 8X DVD-RW Up to 8X DVD-RW Up to 8X DVD-ROM DL Up to 8X DVD-ROM DL Up to 8X DVD-ROM Up to 8X DVD-ROM Up to 8X DVD-ROM DL UP to 8XPowerSource DC Power Requirements 5 VDC - < 800 mA typical, <1600 mA maximu Relative Humidity Condensing)SVDC - < 800 mA typical, <1600 mA maximu Maximum Wet Bulb Maximum Wet Bulb 84° F (29° C) TemperatureOperating Systems SupportedWindows 11, Windows 10, Windows 7Professional 64-bit, Windows Vista Business 64', Windows 2000. Red Hat'E Enterprise Linux® (RHEL) 8, 9 Desktop/Workstation SUSE Linux® Enterprise Desktop 15 Ubuntu 20.04, 22.04 LTS				
CD-R CD-RWSigned by the constraint of				
Disc Capacity DUD-ROM 8.5 GB D. or 4.7 GB standard Full Stroke DVD < 200 ms (seek)				
Full Stroke DVD Full Stroke CD< 200 ms (seek)Maximum Data Transfer RatesCD ROM ReadCD-ROM, CD-R Up to 24X CD-RW Up to 24XDVD ROM ReadDVD-RW Up to 24X CD-RW Up to 24XDVD ROM ReadDVD-RW Up to 8X DVD-R DL Up to 8X DVD-R Up to 8X DVD-R Up to 8XPowerSource DC Power Requirements DC CurrentSATA DC power receptacle S VDC - < 800 mA typical, <1600 mA maximu DOW maximum Wet Bulb Relative Humidity Maximum Wet Bulb SupportedS4* F (29° C) TemperatureOperating Systems SupportedWindows 10, Windows 70, Professional 64-bit, Windows 11, Windows 10, Windows 2000. Red Hat® Enterprise Linux® (RHEL) 8, 9 Desktop/Workstation SUSE Linux® Enterprise Linux®				
Maximum Data Transfer Rates Full Stroke CD < 200 ms (seek)		Disc Capacity	DVD-ROM	8.5 GB DL or 4.7 GB standard
Maximum Data Transfer RatesCD ROM ReadCD-ROM, CD-R Up to 24X CD-RW Up to 24XRatesDVD ROM ReadDVD+RW Up to 8X DVD-RW Up to 8X 			Full Stroke DVD	< 200 ms (seek)
Rates CD-RW Up to 24X DVD ROM Read DVD+RW Up to 8X DVD-RW Up to 8X DVD-RW Up to 8X DVD-R DL Up to 8X DVD-ROM DL Up to 8X DVD-R DM DL Up to 8X DVD-ROM DL Up to 8X DVD-R DL Up to 8X DVD-RVM Up to 8X DVD-R DL Up to 8X DVD-RVM Up to 8X DVD-R DL Up to 8X DVD-RVM DL Up to 8X DVD-R Up to 8X DVD-RVM Up to 8X DVD-R DL Up to 8X DVD-RVM Up to 8X DVD-R DL Up to 8X DVD-RVM Up to 8X DVD-R DL Up to 8X DVD-RVM Up to 8X DVD-R DL Up to 8X DVD-RVM Up to 8X DVD-R DL Up to 8X DVD-RVM Up to 8X DVD-R DL Up to 8X DVD-RVM Up to 8X DVD-R DL Up to 8X DVD-RVM Up to 8X DVD-R DL Up to 8X DVD-RVM PT to 8X DVD-R DL Up to 8X DVD-RVM PT to 8X DVD-R DL Up to 8X DVD-RVM PT to 8X DVD R DL TO 8X NO Tremperature Qperating Environmental remperature 41° to 122° F (5° to 50° C) (all conditions non-condensing) Relative Humidity 10% to 80% Maximum Wet Bulb 84° F (29° C) Temperature Operati			Full Stroke CD	< 200 ms (seek)
DVD-RW Up to 8X DVD+R DL Up to 8X DVD-R DL Up to 8X DVD-R DL Up to 8X DVD-ROM DL Up to 8X DVD-ROM DL Up to 8X DVD-ROM DL Up to 8X DVD-R Up to 8XPowerSource DC Power Requirements DC CurrentSATA DC power receptacle S VDC + 5%-100 mV ripple p-p DC Current S VDC -< 800 mA typical, <1600 mA maximu Operating Environmental (all conditions non- condensing)Relative Humidity Maximum Wet Bulb Relative Humidity 84° F (29° C) Temperature10% to 80% Relative Requirements SupportedOperating Systems SupportedWindows 10, Windows 10, Windows 7 Professional 64-bit, Windows Vista Business 64*, Windows 2000. Red Hat% Enterprise Linux% (RHEL) 8, 9 Desktop/Workstation SUSE Linux% Enterprise Desktop 15 Ubuntu 20.04, 22.04 LTS9. Desktop/Workstation support is provided by the operating system			CD ROM Read	
PowerSourceSATA DC power receptacleDVD-R Up to 8XDVD-R Up to 8XDVD-R Up to 8XDVD-R Up to 8XPowerSourceDVD-R Up to 8XDVD-R Up to 8XSVDC -< 800 mA typical, <1600 mA maximuOperating Environmental (all conditions non- condensing)TemperatureRelative Humidity Maximum Wet Bulb Harimum Wet Bulb Windows 11, Windows 10, Windows 7 Professional 64-bit, Windows Vista Business 64*, Windows 2000. Red Hat® Enterprise Linux® (RHEL) 8, 9 Desktop/Workstation SUSE Linux® Enterprise Desktop 15 Ubuntu 20.04, 22.04 LTS* No driver is required for this device. Native support is provided by the operating system			DVD ROM Read	
DVD-R DL Up to 8X DVD-ROM DL Up to 8X DVD-ROM DL Up to 8X DVD-R Up to 8XPowerSource DC Power Requirements DC CurrentSATA DC power receptacle 5 VDC ± 5%-100 mV ripple p-p DC CurrentOperating Environmental (all conditions non- condensing)Temperature Maximum Wet Bulb Windows 11, Windows 10, Windows 7 Professional 64-bit, Windows 11, Windows 10, Windows 7 Professional 64-bit, Windows 11, Windows 10, By Desktop/Workstation SUSE Linux® Enterprise Linux® (RHEL) 8, 9 Desktop/Workstation SUSE Linux® Enterprise Desktop 15 Ubuntu 20.04, 22.04 LTS				
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PowerSourceSATA DC power receptacleDC Power Requirements5 VDC ± 5%-100 mV ripple p-pDC Current5 VDC -< 800 mA typical, <1600 mA maximu				•
PowerSourceSATA DC power receptacleDC Power Requirements5 VDC ± 5%-100 mV ripple p-pDC Current5 VDC -< 800 mA typical, <1600 mA maximu				•
DC Power Requirements5 VDC ± 5%-100 mV ripple p-pDC Current5 VDC -< 800 mA typical, <1600 mA maximu				•
DC Current5 VDC -< 800 mA typical, <1600 mA maximuOperating Environmental (all conditions non- condensing)Temperature41° to 122° F (5° to 50° C)Relative Humidity10% to 80%Maximum Wet Bulb Maximum Wet Bulb84° F (29° C)TemperatureWindows 11, Windows 10, Windows 7 Professional 64-bit, Windows Vista Business 64*, Windows 2000. Red Hat® Enterprise Linux® (RHEL) 8, 9 Desktop/Workstation SUSE Linux® Enterprise Desktop 15 Ubuntu 20.04, 22.04 LTS* No driver is required for this device. Native support is provided by the operating system		Power	Source	SATA DC power receptacle
Operating Environmental (all conditions non- condensing)Temperature41° to 122° F (5° to 50° C) (all conditions non- condensing)Maximum Wet Bulb Temperature84° F (29° C) TemperatureOperating Systems SupportedWindows 11, Windows 10, Windows 7 Professional 64-bit, Windows Vista Business 64*, Windows 2000. Red Hat® Enterprise Linux® (RHEL) 8, 9 Desktop/Workstation SUSE Linux® Enterprise Desktop 15 Ubuntu 20.04, 22.04 LTS* No driver is required for this device. Native support is provided by the operating system			DC Power Requirements	5 VDC ± 5%-100 mV ripple p-p
(all conditions non- condensing)Relative Humidity10% to 80% Maximum Wet Bulb84° F (29° C) TemperatureOperating Systems SupportedWindows 11, Windows 10, Windows 7 Professional 64-bit, Windows Vista Business 64*, Windows 2000. Red Hat® Enterprise Linux® (RHEL) 8, 9 Desktop/Workstation SUSE Linux® Enterprise Desktop 15 Ubuntu 20.04, 22.04 LTS* No driver is required for this device. Native support is provided by the operating system			DC Current	5 VDC -< 800 mA typical, <1600 mA maximum
condensing)Maximum Wet Bulb84° F (29° C) Maximum Wet Bulb 84° F (29° C) TemperatureOperating Systems Windows 11, Windows 10, Windows 7 Professional 64-bit, Windows Vista Business 64*, Windows 2000. Red Hat® Enterprise Linux® (RHEL) 8, 9 Desktop/Workstation SUSE Linux® Enterprise Desktop 15 Ubuntu 20.04, 22.04 LTS* No driver is required for this device. Native support is provided by the operating system			Temperature	41° to 122° F (5° to 50° C)
Operating Systems SupportedWindows 11, Windows 10, Windows 7 Professional 64-bit, Windows Vista Business 64*, Windows 2000. Red Hat® Enterprise Linux® (RHEL) 8, 9 Desktop/Workstation SUSE Linux® Enterprise Desktop 15 Ubuntu 20.04, 22.04 LTS* No driver is required for this device. Native support is provided by the operating system		-	Relative Humidity	10% to 80%
SupportedWindows Vista Business 64*, Windows 2000. Red Hat® Enterprise Linux® (RHEL) 8, 9 Desktop/Workstation SUSE Linux® Enterprise Desktop 15 Ubuntu 20.04, 22.04 LTS* No driver is required for this device. Native support is provided by the operating system		condensing)		84° F (29° C)
SUSE Linux® Enterprise Desktop 15 Ubuntu 20.04, 22.04 LTS * No driver is required for this device. Native support is provided by the operating system			Windows Vista Business 64*, Windows 2000.	
operating system			SUSE Linux [®] Enterprise Des	
Kit Contents HP SATA DVD Writer drive, installation guide.				
		Kit Contents	HP SATA DVD Writer drive, i	nstallation guide.

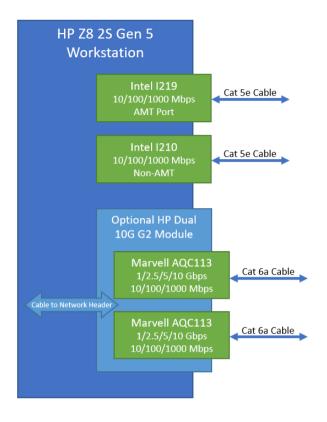


NOTE: Actual speeds may vary. No support for DVD-RAM (DVD Writer). Does not permit copying of commercially available DVD movies or other copyright protected materials. Intended for creation and storage of your original material and other lawful uses. Double Layer discs can store more data than single layer discs. However, double-layer discs burned with this drive may not be compatible with many existing single-layer DVD drives and players.

HP 9.5mm Slim DVD-ROM	Description	9.5mm height, tray-load		
	Mounting Orientation	Either horizontal or vertical		
	Interface Type	SATA/ATAPI		
	Dimensions (WxHxD)	128 x 9.5 x 127mm		
	Disc Capacity	DVD-ROM	Single layer: Up to 4.7 GB Double layer: Up to 8.5 GB	
	Access Times	DVD-ROM Single Layer	< 110 ms (typical)	
		CD-ROM Mode 1	< 110 ms (typical)	
		Full Stroke DVD	< 230 ms (typical)	
		Full Stroke CD	< 220 ms (typical)	
	Power	Source	SATA DC power receptacle	
		DC Power Requirements	5 VDC ± 5%-100 mV ripple p-p	
		DC Current	5 VDC -< 800 mA typical, <1600 mA maximum	
	Operating Environmental (all conditions non- condensing)	Temperature	41° to 122° F (5° to 50° C)	
		Relative Humidity	10% to 80%	
		Maximum Wet Bulb Temperature	84° F (29° C)	
	Operating Systems Supported	Windows 11, Windows 10, Windows 8.1, Windows 7 Professional 64-bit Red Hat® Enterprise Linux® (RHEL) 8, 9 Desktop/Workstation SUSE Linux® Enterprise Desktop 15 Ubuntu 20.04, 22.04 LTS		
		No driver is required for this operating system.	s device. Native support is provided by the	
	Kit Contents	9.5mm Slim DVD-ROM Drive data/power cable, installat	e, 5.25"" ODD Bay adapter/carrier, slim SATA ion guide	
	commercially available DV	D movies or other copyright	M (DVD Writer). Does not permit copying of protected materials. Intended for creation and . Double Layer discs can store more data than	

commercially available DVD movies or other copyright protected materials. Intended for creation and storage of your original material and other lawful uses. Double Layer discs can store more data than single layer discs. However, double-layer discs burned with this drive may not be compatible with many existing single-layer DVD drives and players.

NETWORKING AND COMMUNICATIONS



1219	Connector	RJ-45
(integrated)	Cabling	Up to 100m with Cat 5e or better
-	Controller	Intel I219LM
	Memory	N/A
	Data Rates Supported	10/100/1000Mbps
	Compliance	IEEE 802.3az, 802.3u, 802.1as/1588, 802.1Q, 802.1p
	Bus Architecture	
		PCIe
	Data Transfer Mode	BASE-T
	Power Requirements	N/A
	Network Transfer Mode	BASE-T
	Network Transfer Rate	10/100/1000Mbps
	Management Capabilities	Intel AMT, Wake-on-LAN, PXE, UEFI
	Kit Contents	Integrated into system
	_	
1210	Connector	RJ-45
(integrated)	Cabling	Up to 100m with Cat 5e or better
	Controller	Intel I210
	Memory	N/A
	-	



10/100/1000Mbps

Data Rates Supported

Bus Architecture PCIe Data Transfer Mode BASE-T Power Requirements N/A Network Transfer Mode BASE-T Network Transfer Made DASE-T Network Transfer Made DASE-T Network Transfer Made DASE-T Network Transfer Made DASE-T NUDIA® Mellanox® Gonnector Connector 2 x SFP28 Transceiver Cage (Dual Port)* Connector Cabling Depends on transceiver pairing. Typically ON4 or higher MMF LC fiber cabling Depends on transceiver pairing. Typically ON4 or higher MMF LC fiber ConnectX-6 DX Dual Port ConnectV6-DX Controller ConnectX6-DX Memory 256Mbit SPI Quad Flash Device Data Rates Supported 1/10/256bE Compliance -IEEE 802.3by 25 Gigabit Ethernet -IEEE 802.3ag based auto-negotiation and KR startup -IEEE 802.1Qau (QCN) -Congestion Notification -IEEE 802.1Qau (QCN) -Congestion Notification -IEEE 802.1Qb (PFC) -IEE
Power Requirements N/A Network Transfer Mode BASE-T Network Transfer Rate 10/100/1000Mbps Management Capabilities Wake-on-LAN, PXE, UEFI Kit Contents Integrated into system NVIDIA® Mellanox® Connector 2 x SFP28 Transceiver Cage (Dual Port)* ConnectX-6 DX Dual Port Cabling Depends on transceiver pairing. Typically OM4 or higher MMF LC fiber cabling with LC SFP28 Transceivers. Controller ConnectX6-DX Memory 256Mbit SPI Quad Flash Device Data Rates Supported 1/10/256bE Compliance
Network Transfer Mode BASE-T Network Transfer Rate 10/100/1000Mbps Management Capabilities Wake-on-LAN, PKE, UEFI Kit Contents Integrated into system NVIDIA® Mellanox® Connector 2 x SFP28 Transceiver Cage (Dual Port)* Connects Connector 2 x SFP28 Transceiver Cage (Dual Port)* Connector Cabling Depends on transceiver pairing. Typically OM4 or higher MMF LC fiber cabling with LC SFP28 Transceivers. Controller ConnectX6-DX Memory 256Mbit SPI Quad Flash Device Data Rates Supported 1/10/256bE Compliance -IEEE 802.30p 25 Gigabit Ethernet - IEEE 802.3ad, 802.1AV.Link Aggregation -IEEE 802.3ad, 802.1AV.Link Aggregation - IEEE 802.1Qau (QCN) -Congestion Notification - IEEE 802.1Qau (QCN) -IEEE 802.1Qau (QCN) - IEEE 802.1Qbb (PFC) -IEEE 802.1Qbb (PFC) - IEEE 802.1Qbb (SFPC) -IEEE 802.1Qbb (SFB) - IEEE 1588v2 -Jumbo frame support (9.6KB) - Safety: CB/CTUVus/CE -MN IES 5535/55032 (Morocco) - UKCA PCIE kgness - stores and accesses Ethernet fabric connection informat and packet data
NVIDIA® Mellanox® ConnectX+6 DX Dual Port 10/25GbE SFP28 NICConnector ConnectX+6 DX Dual Port Cabling2 x SFP28 Transceiver Cage (Dual Port)* Depends on transceiver pairing. Typically OM4 or higher MMF LC fiber cabling with LC SFP28 Transceivers.NVIDIA® Mellanox® ConnectX+6 DX Dual Port 10/25GbE SFP28 NICConnector Cabling2 x SFP28 Transceiver Cage (Dual Port)* Depends on transceiver pairing. Typically OM4 or higher MMF LC fiber cabling with LC SFP28 Transceivers.NVIDIA® Mellanox® ControllerController ConnectX6-DX MemoryConnectX6-DX MemoryData Rates Supported Data Rates Supported1/10/25GbE Compliance1/10/25GbE ComplianceCompliance- IEEE 802.30 by 25 Gigabit Ethernet - IEEE 802.30 by 25 Gigabit Ethernet - IEEE 802.10 Quic (CN) - Congestion Notification - IEEE 802.10 Quic (CN) - CONGE NAVE - AMEN SCOmpliant - KCC - CAN (CES-3 (B) - NM EN 55035/55032 (Morocco) - UKCABus Architecture Data Transfer ModePCI Express - stores and accesses Ethernet fabric connection informat and packet data
Management Capabilities Wake-on-LAN, PXE, UEFI NVIDIA® Mellanox® Connector 2 x SFP28 Transceiver Cage (Dual Port)* ConnectX-6 DX Dual Port Cabling Depends on transceiver pairing. Typically OM4 or higher MMF LC fiber cabling with LC SFP28 Transceivers. Controller ConnectX6-DX Memory 256Mbit SPP Quad Flash Device Data Rates Supported -IEEE 802.3by 25 Gigabit Ethernet -IEEE 802.3a based auto-negotiation and KR startup -IEEE 802.1Qa (QCN) - Congestion Notification -IEEE 802.1Qa (QCN) - IEEE 802.1Qb (PFC) -IEEE 802.1Qbg -IEEE 188v2 -Jumbo frame support (9.6KB) -Safety: CB/CTUVUs/CE -EMC: CF/CC/VCL/IRCM -RoHS Compliant -KCC -CAN (ICES-3 (B) -NM EN 55035/55032 (Morocco) -UKCA Data Transfer Mode PCIE Gen 4 x8 Data Transfer Mode
Kit Contents Integrated into system NVIDIA® Mellanox® ConnectX-6 DX Dual Port 10/25GbE SFP28 NIC Connector 2 x SFP28 Transceiver Cage (Dual Port)* Controller Cohing Depends on transceiver pairing. Typically 0M4 or higher MMF LC fiber cabling with LC SFP28 Transceivers. Controller ConnectX6-DX Memory 256Mbit SPI Quad Flash Device Data Rates Supported 1/10/25GbE Compliance - IEEE 802.3by 25 Gigabit Ethernet - IEEE 802.3ap based auto-negotiation and KR startup - IEEE 802.1Qa (QCN) - Congestion Notification - IEEE 802.1Qa (QCN) - Congestion Notification - IEEE 802.1Qbb (PFC) - IEEE 802.1Qbg (PFC) - IEEE 1588v2 - Jumbo frame support (9.6KB) - Safety: GDy - NM EN 55035/55032 (Morocco) - UKCA Bus Architecture PCIE Gen 4 x8 PCIE Spress - stores and accesses Ethernet fabric connection informat and packet data
Kit Contents Integrated into system NVIDIA® Mellanox® ConnectX-6 DX Dual Port 10/25GbE SFP28 NIC Connector 2 x SFP28 Transceiver Cage (Dual Port)* Controller Cohing Depends on transceiver pairing. Typically 0M4 or higher MMF LC fiber cabling with LC SFP28 Transceivers. Controller ConnectX6-DX Memory 256Mbit SPI Quad Flash Device Data Rates Supported 1/10/25GbE Compliance - IEEE 802.3by 25 Gigabit Ethernet - IEEE 802.3ap based auto-negotiation and KR startup - IEEE 802.1Qa (QCN) - Congestion Notification - IEEE 802.1Qa (QCN) - Congestion Notification - IEEE 802.1Qbb (PFC) - IEEE 802.1Qbg (PFC) - IEEE 1588v2 - Jumbo frame support (9.6KB) - Safety: GDy - NM EN 55035/55032 (Morocco) - UKCA Bus Architecture PCIE Gen 4 x8 PCIE Spress - stores and accesses Ethernet fabric connection informat and packet data
ConnectX-6 DX Dual Port 10/25GbE SFP28 NICCablingDepends on transceiver pairing. Typically OM4 or higher MMF LC fiber cabling with LC SFP28 Transceivers.ControllerConnectX6-DXMemory256Mbit SPI Quad Flash DeviceData Rates Supported1/10/25GbECompliance- IEEE 802.3by 25 Gigabit Ethernet - IEEE 802.3ae 10 Gigabit Ethernet - IEEE 802.3ae 10 Gigabit Ethernet - IEEE 802.3ae 10 Gigabit Ethernet - IEEE 802.10a QC.1P VLAN tags and priority - IEEE 802.10au (QCN) - Congestion Notification - IEEE 802.10pd (PFC) - IEEE 8
10/25GbE SFP28 NIC Controller ConnectX6-DX Memory 256Mbit SPI Quad Flash Device Data Rates Supported 1/10/25GbE Compliance - IEEE 802.3by 25 Gigabit Ethernet - IEEE 802.3ag based auto-negotiation and KR startup - IEEE 802.3ag, 802.1AX Link Aggregation - IEEE 802.1Qau (QCN) - IEEE 802.1Qau (QCN) - IEEE 802.1Qau (QCN) - IEEE 802.1Qau (DCN) - IEEE 802.1Qau (DCN) - IEEE 802.1Qau (CN) - IEEE 802.1Qau (ETS) - IEEE 802.1Qau (CN) - IEEE 802.1Qau (CN) - IEEE 802.1Qau (CN) - IEEE 802.1Qau (CN)
Memory256Mbit SPI Quad Flash DeviceData Rates Supported1/10/25GbECompliance- IEEE 802.3by 25 Gigabit Ethernet - IEEE 802.3ae 10 Gigabit Ethernet - IEEE 802.3ap based auto-negotiation and KR startup - IEEE 802.1ap based auto-negotiation and KR startup - IEEE 802.1Qau (QCN) - IEEE 802.1Qau (QCN) - Congestion Notification - IEEE 802.1Qau (QCN) - IEEE 802.1Qab (PFC) - IEEE 802.1Qbb (PFC) - IEEE 1588v2 - Jumbo frame support (9.6KB) - Safety: CB/cTUVus/CE - EMC: CC/FCC/VCCI/RCM - RoHS Compliant - KCC - CAN ICES-3 (B) - NM EN 55035/55032 (Morocco) - UKCABus ArchitecturePCI egen 4 x8Data Transfer ModePCI Express - stores and accesses Ethernet fabric connection informal and packet data
Data Rates Supported1/10/25GbECompliance- IEEE 802.3by 25 Gigabit Ethernet - IEEE 802.3ae 10 Gigabit Ethernet - IEEE 802.3ap based auto-negotiation and KR startup - IEEE 802.3ad, 802.1AX Link Aggregation - IEEE 802.1Q av (QCN) - Congestion Notification - IEEE 802.1Qaz (ETS) - IEEE 802.1Qbg - IEEE 802.1Qbg - IEEE 1588v2 - Jumbo frame support (9.6KB) - Safety: CB/CTUVus/CE - EMC: CE/FCC/VCCI/RCM - RoHS Compliant - KCC - CAN ICES-3 (B) - NM EN 55035/55032 (Morocco) - UKCABus ArchitecturePCIe Gen 4 x8 PCI Express - stores and accesses Ethernet fabric connection informat and packet data
Compliance- IEEE 802.3by 25 Gigabit Ethernet - IEEE 802.3ae 10 Gigabit Ethernet - IEEE 802.3ap based auto-negotiation and KR startup - IEEE 802.3ad, 802.1AX Link Aggregation - IEEE 802.1Qau (QCN) - Congestion Notification - IEEE 802.1Qau (ETS) - IEEE 802.1Qbb (PFC) - IEEE 802.1Qbg - IEEE 802.1Qbg - IEEE 1588v2 - Jumbo frame support (9.6KB) - Safety: CB/CTUVus/CE - EMC: CE/FCC/VCCI/RCM - RoHS Compliant - KCC - CAN ICES-3 (B) - NM EN 55035/55032 (Morocco) - UKCABus ArchitecturePCIe Gen 4 x8 PCI Express - stores and accesses Ethernet fabric connection informal and packet data
 IEEE 802.3ae 10 Gigabit Ethernet IEEE 802.3ap based auto-negotiation and KR startup IEEE 802.3ad, 802.1AX Link Aggregation IEEE 802.1Q, 802.1P VLAN tags and priority IEEE 802.1Qau (QCN) Congestion Notification IEEE 802.1Qaz (ETS) IEEE 802.1Qbg IEEE 1588v2 Jumbo frame support (9.6KB) Safety: CB/CTUVus/CE EMC: CE/FCC/VCCI/RCM RoHS Compliant KCC CAN ICES-3 (B) NM EN 55035/55032 (Morocco) UKCA PCIE Gen 4 x8 PCI Express - stores and accesses Ethernet fabric connection informat and packet data
Data Transfer ModePCI Express - stores and accesses Ethernet fabric connection informat and packet data
and packet data
Power Requirements 11.5 Watts (typical)
Network Transfer Rate 1Gbps, 10Gbps, 25Gbps
NOTE: Network Transfer Rate depends on transceiver model.*
Kit Contents NVIDIA® Mellanox® ConnectX-6 DX Dual Port 10/25GbE SFP28 NIC
HP Dual Port 10GBase-T Networking Interface 2 RJ-45
NIC Module G2 System Interface Cabled from Dedicated Rear I/O Slot
Networking Speeds 10Gbps, 5Gbps, 2.5Gbps, 1Gbps, 100Mbps, 10Mbps Supported



	Cabling (up to 100m)	Cat5e (or higher) for 1Gbps Cat6a (or higher) for 10Gbps
	Power Consumption (active-typical)	5.5W at 1Gbps 11.2W at 10Gbps
	Physical Dimensions	0.875 in x 3 in x 2.75 in
	Connect Speed LED Indicators	Link/Activity LED Off = No link Blinking = Activity Speed LED Amber = 1Gbps Green = 10Gbps
	Operating Temperature	
Intel® X550 10GBASE-T	Connector	2 x RJ-45
Dual Port NIC	Cabling	Cat5 (or higher) for 100Mbps Cat5e (or higher) for 1Gbps, 2.5Gbps, or 5Gbps Cat6 (or higher) for 10Gbps up to 55m Cat6a (or higher) for 10Gbps up to 100m
	Controller	Intel X550-AT2
	Memory	Jumbo Frames up to 15.5KB, 64 Tx and 64Rx Queues per port, 160KB/port of programmable memory transmit buffers
	Data Rates Supported	100Mbps (BASE-TX), 1Gbps (BASE-T, 2.5Gbps, 5Gbps, 10Gbps
	Compliance	802.1q (VLAN), 802.1Qbb, 802.1p, 802.1Qaz
	Bus Architecture	PCIe 3x4
	Data Transfer Mode	PCIe Gen 3 x4 based interface
	Power Requirements	3.9W at 100Mbps 5.5W at 1Gbps 11.2W at 10Gbps
	Boot ROM Support	Yes
	Network Transfer Mode	Auto negotiation between 1GbE, 2.5GbE, 5GbE and 10GbE
	Management Capabilities	DMI 2.0 Support, Windows Management Instrumentation (WMI) and SNMP, PXE 2.0 through boot ROM, Multi-mode I/O Virtualization, VxLAN, VMDq, VLAN support with VLAN tag insertion
	Kit Contents	Intel® X550 10GBASE-T Dual Port NIC
Intel® I225-T1 Single	Connector	RJ-45 (Single Port)
Port 2.5GbE PCIe NIC	Cabling	Cat5e (or better) up to 100m
	Controller	Intel® Ethernet I225 Controller
	Memory	Jumbo Frames up to 9.5KB, 4 Tx and Rx Queues,
	Data Rates Supported	2.5GbE, 1GbE, 100MbE, 10MbE
	Compliance	IEEE 802.3 auto negotiation, 802.3x, 802.3z
	Bus Architecture	PCIe Gen 3.1x1
	Data Transfer Mode	PCIe-based interface for active state operation
	Power Requirements	1.9 Watts (typical)



	Management Capabilities	WOL, PXE 2.1, Power Management Protocol Offload (proxying), MAC Power Management, Active State Power Management,
	Kit Contents	Intel® I225-T1 1-Port 2.5GbE NIC with standard height bracket attached and Low-profile bracket included Product Literature
Intel® Ethernet 1350-	Connector	4x RJ-45 (Quad Port)
T4V2 4-Port 1Gb NIC	Cabling	Cat3 (or higher) for 10Mbps Cat5 (or higher) for 100Mbps Cat5e (or higher) for 1Gbps up to 100m
	Controller	Intel® I350
	Memory	Jumbo Frames up to 9.5KB, 8 Tx/Rx Queue pairs per port, Main Internal memory is Error Code Correcting
	Data Rates Supported	10Mbps, 100Mbps, 1Gbps
	Compliance	IEEE 802.3 auto negotiation, 802.3, 802.3u, 802.3ab, 802.3x, 802.3z, IEEE1588 protocol and 802.1AS implementation, 802.3az EEE
	Bus Architecture	PCI Express 2.1 x4
	Data Transfer Mode	PCIe-based interface for active state operation
	Power Requirements	5W
	Network Transfer Mode	Multi-speed, full, and half-duplex
	Network Transfer Rate	10BASE-T 100BASE-Tx 1000BASE-T
	Management Capabilities	WOL, PXE 2.1, UEFI, Power Management Protocol Offload (proxying), MAC Power Management, Active State Power Management, VLAN, ACPI
	Kit Contents	Intel® Ethernet I350-T4V2 4-Port 1Gb NIC with full-height bracket installed Low-profile bracket included
Allied Telesis AT-	Connector	2 x RJ-45 (Dual Port)
2911T/2-901 Dual Port 1GbE NIC	Cabling	Cat3 (or higher) for 10Mbps Cat5 (or higher) for 100Mbps Cat5e (or higher) for 1Gbps up to 100m
	Memory	17 Rx and 16 Tx queues
	Data Rates Supported	10/100/1000 Mbps
	Compliance	IEEE 802.1p (Quality of Service), IEEE 802.1Q (VLANS), IEEE 802.2 (LLC), IEEE 802.3ac (MAC), IEEE 802.3x (Flow control auto-negotiation), IEEE 802.3z (1000 Base-X), IEEE 802.3ad (Link aggregation), IEEE 802.3ab (10/100/1000T) RoHS, UL, FCC/EN55022 Class A, TUV, EN55024, CE, C-TICK, VCCI
	Bus Architecture	PCIe 2x1
	Data Transfer Mode	PCIe-based interface
	Power Requirements	2.4 Watts (typical)
	Management Capabilities	VLAN support, Link aggregation LACP, Link aggregation smart switch, Failover, Smart Load Balancing (SLB), iSCSI boot support, Windows Management Instrumentation (WMI), PXE 2.1, SNMP
	Kit Contents	Allied Telesis AT-2911T/2-901 Dual Port 1GbE NIC with low-profile bracket attached and standard bracket included



Technical Specifications - Networking and Communications

Allies Telesis AT-	Connector		LC Fiber (Single Port)
2914SX/LC 1GB LC Fibe NIC	^r Cabling		50/125 μm (core/cladding) multimode fiber optic cable up to 500m 62.5/125 μm (core/cladding) multimode fiber optic cable up to 220m
	Memory		Jumbo Frames up to 9.6KB
	Data Rates Supported	d	1000SX (1GbE Fiber at 850nm Wavelength)
	Compliance		IEEE 802.1p (Quality of Service), IEEE 802.1Q (VLANs), IEEE 802.2 (LLC), IEEE 802.3ac (MAC), IEEE 802.3x (Flow control auto-negotiation), IEEE 802.3z (1000 Base-X), IEEE 802.3ad (Link aggregation) RoHS, UL, FCC/EN55022 Class A, TUV, EN55024, CE, C-TICK, VCCI
	Bus Architecture		PCIe x1
	Data Transfer Mode		PCIe-based interface
	Power Requirements		1.5 Watts (typical)
	Network Transfer Rat	te	1000SX only (1GbE Fiber at 850nm Wavelength)
	Management Capabil		UEFI, Smart Load Balancing and failover, Link aggregation (IEEE802.3ad), Generic trunking (FEC/GEC) / IEEE 802.3ad-draft static, VLAN Support
	Kit Contents		Allied Telesis AT-2914SX/LC 1GB LC Fiber NIC with low-profile bracket attached and standard height bracket included
Intel® AX210 Wi-Fi 6E	Connector		Wireless
non-vPro + Bluetooth® 5.2 wireless card with External Antenna WLAN	' Cabling		N/A
	N Controller		Intel® AX210
	Data Rates Supported	d	Wi-Fi 6e (2.4GHz/5GHz/6GHz)
	Compliance		Wi-Fi Alliance* Wi-Fi Alliance CERTIFIED 6, WiFi CERTIFIED a/b/g/n/ac, WMM, WMM-Power Save, WPA2, WPA3, Wi-Fi Direct, and Wi-Fi Agile Multiband IEEE WLAN Standard 802.11-2016, 802.11a, b, d, e, g, h, I, k, n, r, u, v, w, ac and ax, Bluetooth [®] 5.2
	Bus Architecture		PCIe G3x1 for WLAN, USB3.1G1 for BT
	Management Capabil	ities	Authentication Protocols: 802.1X EAP-TLS, EAP-TTLS/MSCHAPv2, PEAPv0 MSCHAPv2 (EAP-SIM, EAP-AKA, EAP-AKA') Encryption: 128-bit AES-CCMP, 256-bit AES-GCMP UEFI
	Kit Contents		Intel® AX210 Wi-Fi 6 + Bluetooth® 5.2 PCIe NIC External Dipole Antenna Installation Instructions
		s limit	E router, sold separately to function in the 6GHz band. Availability of public red. Wi-Fi 6E is backwards compatible with prior 802.11 specs. And available is supported.
Date of change:	Version History:		Description of change:
		nange	
		nange	ed Image page 1
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lune 1, 2023	From v5 to v6 Ch	nange	ed Graphics, Storage, Networking and Communications, Social and Environmental Responsibility, Overview sections



July 1, 2023

From <u>v6 to v7</u>

Added

Environmental Responsibility, Overview sections

HP Anyware Remote System Controller section

		Changed	Optical and Removable Storage, Networking and Communications sections
August 1, 2023	From v7 to v8	Changed	Storage Drives, Social and Environmental Responsibility sections
August 1, 2023	From v8 to v9	Changed	ENVIRONMENTAL DATA section
September 1,2023	From v9 to v10	Changed	Overview, NETWORKING AND COMMUNICATIONS sections
September 25, 2023	From v10 to v11	Changed	SOFTWARE AND SECURITY section
October 1, 2023	From v11 to v12	Changed	Input Devices section

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